

TSL2585

Miniature Ambient Light Sensor with UV and Light Flicker Detection

General Description

The TSL2585 incorporates Photopic, IR and UV photodiodes that are connected to 3 modulators, provides concurrent ambient light sensing, UV sensing and light flicker detection. The device comes in a low-profile and small footprint, L2.0mm x W1.0mm x H0.35mm OLGA package.

The Photopic photodiode area is covered with an optimized Photopic filter. In association with dedicated IR channel, this architecture accurately measures ambient light and enables the calculation of irradiance of different light sources. Calculation results help to automatically optimize display brightness under different lighting conditions for a better user experience.

The device also integrates functionality of ambient light flicker detection. It is executed in parallel with ambient light sensing by using the same photodiodes. The flicker detection engine will sample and buffer data for calculating flicker frequencies externally on a host CPU.

The UV photodiode area is covered with a band-pass UV filter. In combination with Photopic and IR channels, it is possible to estimate ambient UV index by running an algorithm externally on a host CPU.

Ordering Information and Content Guide appear at end of datasheet.



Key Benefits & Features

The benefits and features of TSL2585 are listed below:

Figure 1: Added Value of Using TSL2585

| Benefits | Features |
|----------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Invisible ALS sensing under any glass type | Configurable, high sensitivity Programmable gain and integration time 4098x dynamic range by gain adjustment only Imlux detectable illuminance Tailored ALS response Photopic filter for visible channel Independent IR channel ALS interrupt with thresholds |
| Integrated light flicker detection on chip | Concurrent flicker and ALS measurement with new simplified readout methodology Independently configurable sample time Up to 7kHz flicker detection (14kHz sampling) FIFO buffer interrupt |
| Auxiliary information for ambient UV index estimation | UVA channel with independent and programmable channel gain Photopic filter for visible channel Independent IR channel |
| Low power consumption and minimum I ² C traffic | 1.8V_{DD} operation Configurable sleep mode Interrupt-driven device I²C interface up to 1Mbit/s (Fast mode) |
| Integrated status checking for all functions | Digital and analog saturation flags |
| Reduced I ² C bus traffic load | On chip data compression |

Applications

TSL2585 integrates multiple applications within one device. The applications include:

- Ambient light sensing for display brightness management
- Ambient UV index estimation
- Auto exposure and flicker detection for camera assistance

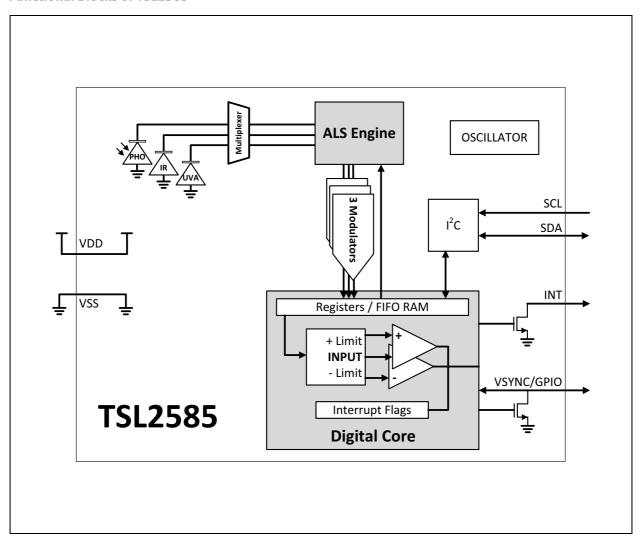
Page 2ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



Block Diagram

The functional blocks of this device are shown below:

Figure 2: Functional Blocks of TSL2585



ams Datasheet Page 3
[v2-00] 2021-Nov-23
Document Feedback



Pin Assignments

Figure 3: Pin Diagram of TSL2585 (top view)

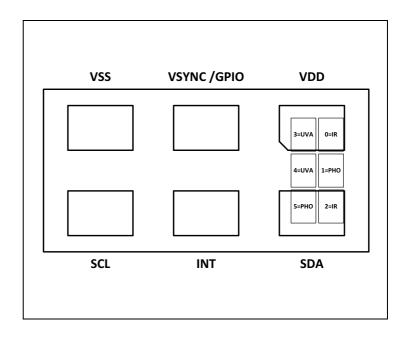


Figure 4: Pin Description of TSL2585

| Pin Number | Pin Name | Description |
|------------|------------|------------------------------------------------------------------|
| 1 | VDD | Supply voltage (1.8V) |
| 2 | VSYNC/GPIO | Synchronization input OR General Purpose open-drain Input/Output |
| 3 | VSS | Ground. All voltages are referenced to VSS. |
| 4 | SCL | I ² C serial clock terminal |
| 5 | INT | Interrupt. Open-drain output. |
| 6 | SDA | I ² C serial data I/O terminal |

Page 4ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

All voltages with respect to VSS. Device parameters are guaranteed at V_{DD} = 1.8V and T_A = 25°C unless otherwise noted.

Figure 5: Absolute Maximum Ratings

| Symbol | Parameter | Min | Max | Units | Comments | | | |
|--------------------|---------------------------------------|------------|-----------|------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----|------------------------|--|
| | El | ectrical P | arameter | S | | | | |
| V _{DD} | Supply Voltage | -0.3 | 1.98 | V | | | | |
| V _{IO} | Digital I/O Terminal Voltage | -0.3 | 3.6 | V | | | | |
| I _{IO} | Output Terminal Current | -1 | 20 | mA | | | | |
| | Electrostatic Discharge | | | | | | | |
| ESD _{HBM} | HBM Electrostatic Discharge | ± 2 | 000 | V | ANSI/ESDA/JEDEC JS-001-2017 | | | |
| ESD _{CDM} | CDM Electrostatic Discharge | ± 5 | 500 | V | ANSI/ESDA/JEDEC JS-002-2018 | | | |
| I _{SCR} | Input Current (latch-up immunity) | ± 100 | | ± 100 | | mA | JEDEC JESD78E Class II | |
| | Temperature | Ranges a | nd Storag | e Conditio | ons | | | |
| T _{STRG} | Storage Temperature Range | -40 | 85 | | | | | |
| T _A | Operating Temperature Range | -30 | 85 | | | | | |
| T _{BODY} | Package Body Temperature | | 260 | °C | IPC/JEDEC J-STD-020. The reflow peak soldering temperature (body temperature) is specified according to IPC/JEDEC J-STD-020 "Moisture/Reflow Sensitivity Classification for Non-hermetic Solid State Surface Mount Devices." | | | |
| RH _{NC} | Relative Humidity (non-condensing) | | 85 | % | | | | |
| MSL | Moisture Sensitivity Level | | 3 | | Represents a max. floor life time of 168h | | | |

ams Datasheet Page 5
[v2-00] 2021-Nov-23
Document Feedback



Optical Characteristics

All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods. Device parameters are guaranteed with $V_{DD}=1.8V$ and $T_A=25^{\circ}C$ unless otherwise noted.

Figure 6:
ALS Characteristics of TSL2585, ALS Gain = 128x, Integration Time = 10ms (unless otherwise noted)

| Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------------------------|-----------------------------------------------------------------|----------|----------|----------|---------------------|
| Dark ADC count value (1) | $E_e = 0\mu W/cm^2$ ALS gain: 512x Integration time: 98ms | 0 | 1 | 3 | counts |
| | 0.5x | 1/270.78 | 1/249.13 | 1/230.68 | |
| | 1x | 1/133.17 | 1/123.85 | 1/115.74 | |
| | 2x | 1/66.99 | 1/62.97 | 1/59.41 | |
| | 4x | 1/33.39 | 1/31.72 | 1/30.21 | |
| | 8x | 1/16.17 | 1/15.53 | 1/14.93 | |
| | 16x | 1/8.30 | 1/7.97 | 1/7.66 | |
| ALS gain ratios (2) | 32x | 1/4.15 | 1/3.99 | 1/3.83 | |
| | 64x | 1/2.09 | 1/2.01 | 1/1.93 | |
| | 256x | 1.78 | 1.93 | 2.07 | |
| | 512x | 3.42 | 3.80 | 4.18 | |
| | 1024x | 6.16 | 7.42 | 8.68 | |
| | 2048x | 10.26 | 14.06 | 17.86 | |
| | 4096x | 11.41 | 25.35 | 39.29 | |
| ADC noise ⁽³⁾ | White LED, 2700K ⁽⁴⁾ Integration time: 100ms | | 0.05 | | % |
| Photopic channel irradiance responsivity | White LED, 2700K ⁽⁴⁾ | 62.7 | 73.7 | 84.8 | counts/ (μW/cm²) |

Page 6ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



| Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------------------|-------------------------------------------------|-----|------|-----|----------|
| IR channel irradiance responsivity | IR LED =940nm ⁽⁵⁾ | | 74.8 | | counts/ |
| UV channel irradiance responsivity | UV LED =365nm ⁽⁶⁾ ALS gain: 1024x | | 82.8 | | (μW/cm²) |
| IR / Photopic channel ratio | White LED, 2700K | | 8.1 | | |
| UV / Photopic channel ratio | White LED, 2700K | | 0.0 | | % |
| Photopic / IR channel ratio | IR LED = 940nm | | 3.6 | | 70 |
| UV / IR channel ratio | IR LED = 940nm | | 0.9 | | |

Note(s):

- 1. The typical 3-sigma distribution shows less than 1 count. For this measurement, each modulator is always connected to one photodiode whereas the photodiodes are sequentially multiplexed.
- 2. The gain ratios are calculated relative to the response with ALS gain = 128x.
- 3. ADC noise is calculated as the standard deviation relative to full scale.
- 4. The White LED is an InGaN light-emitting diode with integrated phosphor and the following characteristic: correlated color temperature = 2700K.
- 5. The IR LED is an AlGaAs light-emitting diode with a peak wavelength of $\lambda_P = 940$ nm.
- 6. The UV LED is an light-emitting diode with a peak wavelength of $\lambda_{\text{P}}=365\text{nm}.$

ams Datasheet Page 7
[v2-00] 2021-Nov-23
Document Feedback



Electrical Characteristics

All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

Figure 7: Recommended Operating Conditions

| Symbol | Parameter | Min | Тур | Max | Units | Comments | | | |
|--------------------|--------------------------------------------------|------|-----|------|-------|----------|--|--|--|
| | Electrical Parameters | | | | | | | | |
| V _{DD} | Supply Voltage | 1.7 | 1.8 | 1.98 | V | | | | |
| V _{DD/IO} | I/O Supply Voltage | 1.62 | 1.8 | 3.3 | V | | | | |
| | Temperature Ranges and Storage Conditions | | | | | | | | |
| T _A | Operating Free-Air Temperature ⁽¹⁾ | -30 | 25 | 85 | °C | | | | |

Note(s):

Figure 8: Electrical Characteristics of TSL2585, $V_{DD} = 1.8V$, $T_A = 25^{\circ}C$ (unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|------------------------------------|-----------------------------------------------------|------|-----|------|------|
| I _{DD;ALS} | ALS supply current | Active ALS state (1) (PON=AEN=1) | | 235 | 290 | |
| I _{DD;IDLE} | Idle current | Idle state ⁽²⁾ (PON=1, AEN=0; FDEN=0) | | 60 | | μΑ |
| I _{DD;SLEEP} | Sleep current | Sleep state (3) | | 0.7 | 5 | |
| I _{LEAK} | Leakage current | Measured on SDA, SCL, INT, GPIO | -5 | | 5 | |
| V _{OL} | INT, SDA, GPIO output low voltage | 6mA sink current | | | 0.4 | |
| V _{IH} | SCL, SDA, VSYNC input high voltage | | 1.26 | | | V |
| V _{IL} | SCL, SDA, VSYNC input low voltage | | | | 0.54 | |

Page 8ams DatasheetDocument Feedback[v2-00] 2021-Nov-23

^{1.} While the device is operational across the temperature range, functionality will vary with temperature.



| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|------------------------------------------------------------------------|------------|-----|-----|-----|------|
| C _I | Input pin capacitance | | | 10 | | pF |
| t _{ACTIVE} | Time from Power-On to Ready to Receive I ² C Commands | | | 0.5 | | ms |

Note(s):

- 1. This parameter indicates the supply current during periods of ALS integration. The ALS gain setting will have an effect on the active supply current. The ALS gain setting used for this parameter is 128x and there are 3 modulators active.
- 2. Idle state occurs when PON=1 and all functions are disabled. This parameter is measured with LOWPOWER_IDLE=1.
- 3. Sleep state occurs when PON = 0 and I^2C bus is idle. If Sleep state has been entered as the result of operational flow, SAI = 1, PONwill remain high.

ams Datasheet Page 9 **Document Feedback**



Timing Characteristics

The timing parameters are specified by design and characterization and are not production tested unless otherwise noted. All parameters are measured with $V_{DD}=1.8V$ and $T_A=25^{\circ}C$ unless otherwise noted.

Figure 9: I²C Timing Characteristics of TSL2585

| Symbol | Parameter | Min | Тур | Max | Unit |
|---------------------|---------------------------------------------------------------------------------------------|-----|-----|-----|------|
| f _{SCL} | I ² C clock frequency | 0 | | 400 | kHz |
| t _{BUF} | Bus free time between start and stop condition | 1.3 | | | |
| t _{HS;STA} | Hold time after (repeated) start condition. After this period, the first clock is generated | 0.6 | | | |
| t _{SU;STA} | Repeated start condition setup time | 0.6 | | | μs |
| t _{SU;STO} | Stop condition setup time | 0.6 | | | • |
| t _{LOW} | SCL clock low period | 1.3 | | | |
| t _{HIGH} | SCL clock high period | 0.6 | | | |
| t _{HD;DAT} | Data hold time | 0 | | | |
| t _{SU;DAT} | Data setup time | 100 | | | ns |
| t _F | Clock/data fall time | | | 300 | 115 |
| t _R | Clock/data rise time | | | 300 | |

Page 10ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



Figure 10: Timing Diagram for TSL2585

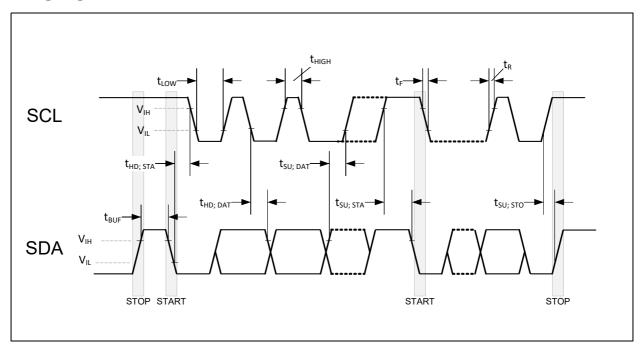


Figure 11: Functional Timing Characteristics of TSL2585

| Symbol | Parameter | Min | Тур | Max | Unit |
|------------------|--------------------------------|-----|-----|-----|------|
| f _{OSC} | Oscillator clock frequency (1) | 700 | 720 | 740 | kHz |

Note(s):

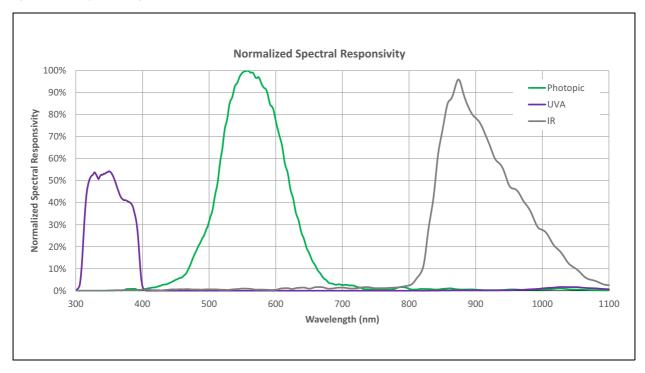
1. 100% production tested.

ams Datasheet Page 11
[v2-00] 2021-Nov-23
Document Feedback



Typical Operating Characteristics

Figure 12: Spectral Responsivity



Note(s):

- 1. The spectral responsivities shown in the figure are measured with 128x AGAIN and 100ms integration time for the Photopic and IR channels and 1024x AGAIN and 100ms integration time for the UV channel. The spectral responsivities are normalized to the Photopic channel.
- 2. The measurements are performed with collimated light and using a rubber boot to block the light leakage through the side walls of the clear mode package.

Page 12ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



Figure 13: **Normalized Angular Response X-Axis**

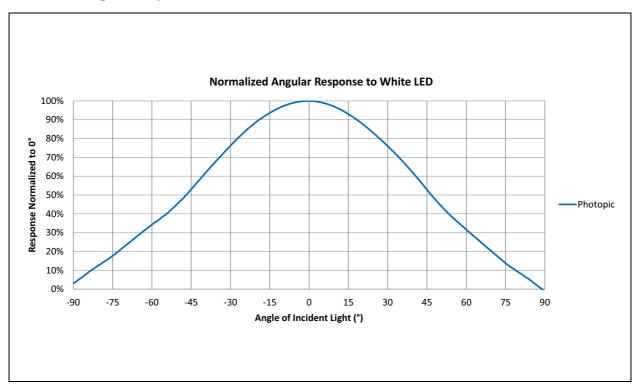
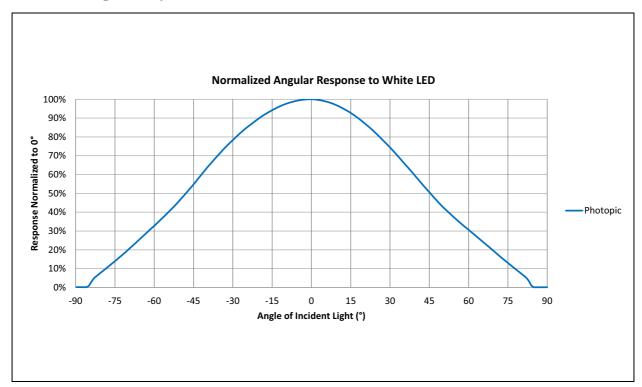


Figure 14: **Normalized Angular Response Y-Axis**



Note(s):

1. The X and Y angular scans have been performed in the lab using an aperture which blocks light leakage through side walls of clear mold package

ams Datasheet Page 13 **Document Feedback**

[v2-00] 2021-Nov-23



Detailed Description

Upon power-up, POR, the device initializes. During initialization (typically 500µs), the device will deterministically send NAK on I^2C and cannot accept I^2C transactions. All communication with the device must be delayed, and all outputs from the device must be ignored including interrupts. After initialization, the device enters the SLEEP state. In this operational state the internal oscillator and other circuitry are not active, resulting in ultra-low power consumption. If an I^2C transaction occurs during this state, the I^2C core wakes up temporarily to service the communication. Once the Power ON bit, PON, is enabled, the device enters the IDLE state in which the internal oscillator and attendant circuitry are active, but power consumption remains low. Whenever a function is enabled (AEN = 1)the device exits the IDLE state. If all functions are disabled (AEN = 0), the device returns to the IDLE state.

As depicted in Figure 15 and Figure 16, the ambient light sensing and flicker sampling functions operate in parallel when enabled. Each function is individually configured (e.g. gain, ADC integration time, wait time, persistence, thresholds, etc.).

If Sleep after Interrupt is enabled (SAI = 1 in register 0xA1), the state machine will enter SLEEP when an interrupt occurs. Entering SLEEP does not automatically change any of the register settings (e.g. PON bit is still high, but the normal operational state is over-ridden by SLEEP state). SLEEP state is terminated when the SAI_ACTIVE bit is cleared (the status bit is in register 0x9F and the clear status bit is in register 0xB1).

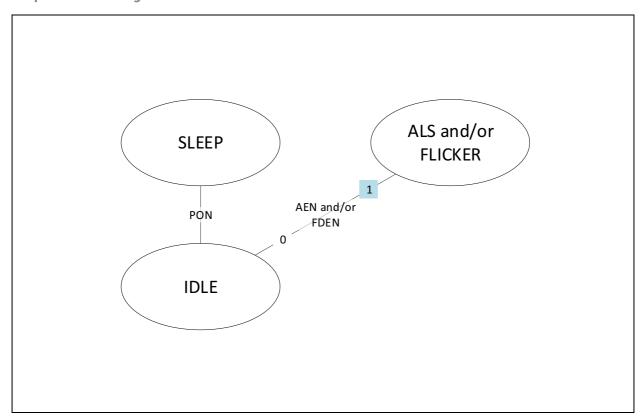
Page 14

Document Feedback [v2-00] 2021-Nov-23



State Machine Diagrams

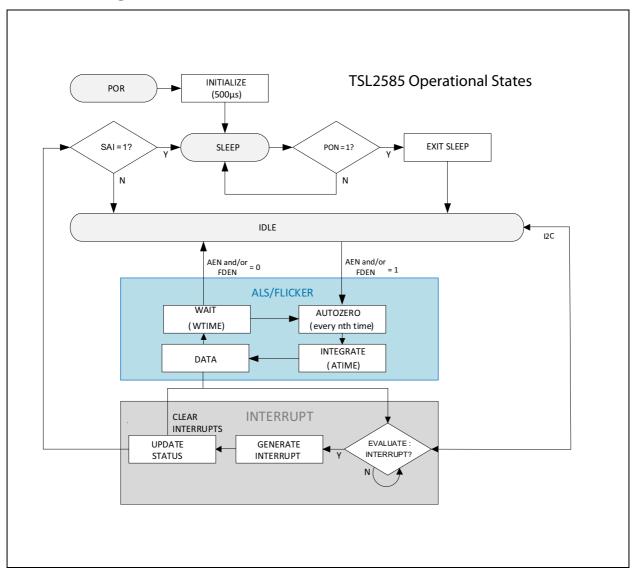
Figure 15: Simplified State Diagram



ams Datasheet Page 15
[v2-00] 2021-Nov-23
Document Feedback



Figure 16: Detailed State Diagram



Page 16ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



I²C Protocol

The device uses I²C serial communication protocol for communication. The device supports 7-bit chip addressing and both standard and full-speed clock frequency modes. Read and Write transactions comply with the standard set by Philips (now NXP). For a complete description of the I²C protocol, please review the NXP I²C design specification.

Internal to the device, an 8-bit buffer stores the register address location of the desired byte to read or write. This buffer auto-increments upon each byte transfer and is retained between transaction events (I.e. valid even after the master issues a STOP command and the I²C bus is released). During consecutive Read transactions, the future/repeated I²C Read transaction may omit the memory address byte normally following the chip address byte; the buffer retains the last register address +1.

All 16-bit fields have a latching scheme for reading and writing. In general it is recommended to use I²C bursts whenever possible, especially in this case when accessing two bytes of one logical entity. When reading these fields, the low byte must be read first, and it triggers a 16-bit latch that stores the 16-bit field. The high byte must be read immediately afterwards. When writing to these fields, the low byte must be written first, immediately followed by the high byte. Reading or writing to these registers without following these requirements will cause errors.

A Write transaction consists of a START, CHIP-ADDRESSWRITE, REGISTER-ADDRESS WRITE, DATA BYTE(S), and STOP. Following each byte (9TH clock pulse) the slave places an ACKNOWLEDGE/NOT- ACKNOWLEDGE (ACK/NACK) on the bus. If NACK is transmitted by the slave, the master may issue a STOP.

A Read transaction consists of a START, CHIP-ADDRESSWRITE, REGISTER-ADDRESS, RESTART, CHIP-ADDRESSREAD, DATA BYTE(S), and STOP. Following all but the final byte the master places an ACK on the bus (9TH clock pulse). Termination of the Read transaction is indicated by a NACK being placed on the bus by the master, followed by STOP.

ams Datasheet Page 17 **Document Feedback**



Register Overview

The device is controlled and monitored by registers accessed through the I²C serial interface. These registers provide device control functions and are read to determine device status and acquire device data.

Register Map

The register set is summarized in Figure 17. The values of all registers and fields that are listed as reserved or are not listed must not be changed at any time. The power-on reset values of each bit are indicated in these columns. Two-byte fields are always latched with the low byte followed by the high byte.

Figure 17: Register Map

| Addr | Name | Description | Reset |
|------|------------------|----------------------------------------|-------|
| 0x08 | UV_CALIB | UV calibration multiplier | ОТР |
| 0x40 | MOD_CHANNEL_CTRL | Modulator channel control | 0x00 |
| 0x80 | ENABLE | Enables device states | 0x00 |
| 0x81 | MEAS_MODE0 | Measurement mode settings 0 | 0x04 |
| 0x82 | MEAS_MODE1 | Measurement mode settings 1 | 0x0C |
| 0x83 | SAMPLE_TIME0 | Flicker sample time settings 0 [7:0] | 0xB3 |
| 0x84 | SAMPLE_TIME1 | Flicker sample time settings 1 [10:8] | 0x00 |
| 0x85 | ALS_NR_SAMPLES0 | ALS measurement time settings 0 [7:0] | 0x00 |
| 0x86 | ALS_NR_SAMPLES1 | ALS measurement time settings 1 [10:8] | 0x00 |
| 0x87 | FD_NR_SAMPLES0 | Flicker number of samples 0 [7:0] | 0x00 |
| 0x88 | FD_NR_SAMPLES1 | Flicker number of samples 1 [10:8] | 0x00 |
| 0x89 | WTIME | Wait time | 0x00 |
| 0x8A | AILT0 | ALS Interrupt Low Threshold [7:0] | 0x00 |
| 0x8B | AILT1 | ALS Interrupt Low Threshold [15:8] | 0x00 |
| 0x8C | AILT2 | ALS Interrupt Low Threshold [23:16] | 0x00 |
| 0x8D | AIHT0 | ALS Interrupt High Threshold [7:0] | 0x00 |
| 0x8E | AIHT1 | ALS Interrupt High Threshold [15:8] | 0x00 |
| 0x8F | AIHT2 | ALS interrupt High Threshold [23:16] | 0x00 |
| 0x90 | AUX_ID | Auxiliary Identification | 0x06 |
| 0x91 | REV_ID | Revision Identification | 0x11 |
| 0x92 | ID | Device Identification | 0x5C |

Page 18
Document Feedback
[v2-00] 2021-Nov-23



| Addr | Name | Description | Reset |
|------|----------------------|--------------------------------------------------------|-------|
| 0x93 | STATUS | Device Status information 1 | 0x00 |
| 0x94 | ALS_STATUS | ALS Status information 1 | 0x00 |
| 0x95 | ALS_DATA0[7:0] | ALS data channel 0 low byte [7:0] | 0x00 |
| 0x96 | ALS_DATA0[15:8] | ALS data channel 0 high byte [15:8] | 0x00 |
| 0x97 | ALS_DATA1[7:0] | ALS data channel 1 low byte [7:0] | 0x00 |
| 0x98 | ALS_DATA1[15:8] | ALS data channel 1 high byte [15:8] | 0x00 |
| 0x99 | ALS_DATA2[7:0] | ALS data channel 2 low byte [7:0] | 0x00 |
| 0x9A | ALS_DATA2[15:8] | ALS data channel 2 high byte [15:8] | 0x00 |
| 0x9B | ALS_STATUS2 | ALS Status information 2 | 0x00 |
| 0x9C | ALS_STATUS3 | ALS Status information 3 | 0x00 |
| 0x9D | STATUS2 | Device Status information 2 | 0x00 |
| 0x9E | STATUS3 | Device Status information 3 | 0x08 |
| 0x9F | STATUS4 | Device Status information 4 | 0x00 |
| 0xA0 | STATUS5 | Device Status information 5 | 0x00 |
| 0xA1 | CFG0 | Configuration 0 | 0x08 |
| 0xA2 | CFG1 | Configuration 1 | 0x00 |
| 0xA3 | CFG2 | Configuration 2 | 0x01 |
| 0xA4 | CFG3 | Configuration 3 | 0x00 |
| 0xA5 | CFG4 | Configuration 4 | 0x00 |
| 0xA6 | CFG5 | Configuration 5 | 0x00 |
| 0xA7 | CFG6 | Configuration 6 | 0x03 |
| 0xA8 | CFG7 | Configuration 7 | 0x01 |
| 0xA9 | CFG8 | Configuration 8 | 0xC4 |
| 0xAA | CFG9 | Configuration 9 | 0x00 |
| 0xAC | AGC_NR_SAMPLES[7:0] | Number of samples for measurement with AGC low [7:0] | 0x00 |
| 0xAD | AGC_NR_SAMPLES[10:8] | Number of samples for measurement with AGC high [10:8] | 0x00 |
| 0xAE | TRIGGER_MODE | Wait Time Mode | 0x00 |
| 0xB1 | CONTROL | Device control settings | 0x00 |
| 0xBA | INTENAB | Enable interrupts | 0x00 |

ams Datasheet Page 19
[v2-00] 2021-Nov-23 Document Feedback



| Addr | Name | Description | Reset |
|------|-------------------------------------|----------------------------------------------------------------------------------------------------------------|-------|
| 0xBB | SIEN | Enable saturation interrupts | 0x00 |
| 0xCE | MOD_COMP_CFG1 | Adjust AutoZero range | 0x80 |
| 0xCF | MEAS_SEQR_FD_0 | Flicker measurement with sequencer on modulator0 | 0x01 |
| 0xD0 | MEAS_SEQR_ALS_FD_1 | ALS measurement with sequencer on all modulators | 0x01 |
| 0xD1 | MEAS_SEQR_APERS_AND_VSYNC_ WAIT | Defines the measurement sequencer pattern | 0x01 |
| 0xD2 | MEAS_SEQR_RESIDUAL_0 | Residual measurement configuration with sequencer on modulator 0 and modulator 1 | 0xFF |
| 0xD3 | MEAS_SEQR_RESIDUAL_1_AND_ WAIT | Residual measurement configuration with sequencer on modulator2 and wait time configuration for all sequencers | 0x1F |
| 0xD4 | MEAS_SEQR_STEP0_MOD_GAINX_L | Gain of modulator0 and modulator1 for sequencer step 0 | 0x88 |
| 0xD5 | MEAS_SEQR_STEP0_MOD_GAINX_H | Gain of modulator2 for sequencer step 0 | 0x08 |
| 0xD6 | MEAS_SEQR_STEP1_MOD_GAINX_L | Gain of modulator0 and modulator1 for sequencer step 1 | 0x88 |
| 0xD7 | MEAS_SEQR_STEP1_MOD_GAINX_H | Gain of modulator2 for sequencer step 1 | 0x08 |
| 0xD8 | MEAS_SEQR_STEP2_MOD_GAINX_L | Gain of modulator0 and modulator1 for sequencer step 2 | 0x88 |
| 0xD9 | MEAS_SEQR_STEP2_MOD_GAINX_H | Gain of modulator2 for sequencer step 2 | 0x08 |
| 0xDA | MEAS_SEQR_STEP3_MOD_GAINX_L | Gain of modulator0 and modulator1 for sequencer step 3 | 0x88 |
| 0xDB | MEAS_SEQR_STEP3_MOD_GAINX_H | Gain of modulator2 for sequencer step 3 | 0x08 |
| 0xDC | MEAS_SEQR_STEP0_MOD_PHDX_ SMUX_L | Photodiode 0-3 to modulator mapping through multiplexer for sequencer step 0 | 0x66 |
| 0xDD | MEAS_SEQR_STEP0_MOD_PHDX_ SMUX_H | Photodiode 4-5 to modulator mapping through multiplexer for sequencer step 0 | 0x06 |
| 0xDE | MEAS_SEQR_STEP1_MOD_PHDX_ SMUX_L | Photodiode 0-3 to modulator mapping through multiplexer for sequencer step 1 | 0x84 |
| 0xDF | MEAS_SEQR_STEP1_MOD_PHDX_ SMUX_H | Photodiode 4-5 to modulator mapping through multiplexer for sequencer step 1 | 0xF3 |
| 0xE0 | MEAS_SEQR_STEP2_MOD_PHDX_ SMUX_L | Photodiode 0-3 to modulator mapping through multiplexer for sequencer step 2 | 0x07 |
| 0xE1 | MEAS_SEQR_STEP2_MOD_PHDX_ SMUX_H | Photodiode 4-5 to modulator mapping through multiplexer for sequencer step 2 | 0xF8 |
| 0xE2 | MEAS_SEQR_STEP3_MOD_PHDX_ SMUX_L | Photodiode 0-3 to modulator mapping through multiplexer for sequencer step 3 | 0x24 |

Page 20ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



| Addr | Name | Description | Reset |
|------|-------------------------------------|------------------------------------------------------------------------------|-------|
| 0xE3 | MEAS_SEQR_STEP3_MOD_PHDX_ SMUX_H | Photodiode 4-5 to modulator mapping through multiplexer for sequencer step 3 | 0x03 |
| 0xE4 | MOD_CALIB_CFG0 | Modulator calibration config0 | 0xFF |
| 0xE6 | MOD_CALIB_CFG2 | Modulator calibration config2 | 0xD3 |
| 0xF2 | VSYNC_PERIOD[7:0] | Measured VSYNC period | 0x00 |
| 0xF3 | VSYNC_PERIOD[15:8] | Read and clear measured VSYNC period | 0x00 |
| 0xF4 | VSYNC_PERIOD_TARGET[7:0] | Targeted VSYNC period | 0x00 |
| 0xF5 | VSYNC_PERIOD_TARGET[14:8] | Alternative target VSYNC period | 0x00 |
| 0xF6 | VSYNC_CONTROL | Control of VSYNC period | 0x00 |
| 0xF7 | VSYNC_CFG | Configuration of VSYNC input | 0x00 |
| 0xF8 | VSYNC_GPIO_INT | Configuration of GPIO pin | 0x02 |
| 0xF9 | MOD_FIFO_DATA_CFG0 | Configuration of FIFO access for modulator 0 | 0x8F |
| 0xFA | MOD_FIFO_DATA_CFG1 | Configuration of FIFO access for modulator 1 | 0x8F |
| 0xFB | MOD_FIFO_DATA_CFG2 | Configuration of FIFO access for modulator 2 | 0x8F |
| 0xFC | FIFO_THR | Configuration of FIFO threshold interrupt | 0x7F |
| 0xFD | FIFO Level | Number of bytes in FIFO (0-512) | 0x00 |
| 0xFE | FIFO_STATUS0 | FIFO overflow/underflow status | 0x00 |
| 0xFF | FIFO_DATA | FIFO readout | 0x00 |

ams Datasheet Page 21
[v2-00] 2021-Nov-23
Document Feedback



Register Descriptions

UV_CALIB Register

Figure 18: UV_CALIB

| Addr: 0x08 | | UV_CALIB | | | | | | | |
|------------|----------|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|--|--|--|--|
| Bit | Field | Reset | Туре | Bit Description | | | | | |
| | | | | The UV responsivity of each device is calibrated, and the calibration multiplier is stored in this OTP register. The UV_CALIB value is in percentage. Each step is 1%. Value 127 is 0%. UV_Calibrated_Data=UV_Raw_Data*(1+ (UV_CALIB-127)/100), where the UV_Raw_Data is the value read from ALS Data Registers or FIFO Registers. | | | | | |
| | | | | UV_CALIB | Multiplier | | | | |
| | | | | 0 | | | | | |
| | | | | | · | | | | |
| | | | | 121 | -6.0% | | | | |
| | | | | 122 | -5.0% | | | | |
| | | | | 123 | -4.0% | | | | |
| | | | | 124 | -3.0% | | | | |
| 7:0 | UV_CALIB | OTP | R | 125 | -2.0% | | | | |
| | | | | 126 | -1.0% | | | | |
| | | | | 127 | 0.0% | | | | |
| | | | | 128 | 1.0% | | | | |
| | | | | 129 | 2.0% | | | | |
| | | | | 130 | 3.0% | | | | |
| | | | | 131 | 4.0% | | | | |
| | | | | 132 | 5.0% | | | | |
| | | | | 133 | 6.0% | | | | |
| | | | | | · | | | | |
| | | | | 255 | | | | | |

Note(s):

1. Return to the Register Map (0x08).

Page 22ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



MOD_CHANNEL_CTRL Register

Figure 19: MOD_CHANNEL_CTRL

| | Addr: 0x40 | | MOD_CHANNEL_CTRL | | | | |
|-----|--------------|-------|------------------|---------------------------------------|--|--|--|
| Bit | Field | Reset | Type | Bit Description | | | |
| 7:3 | Reserved | 0 | | | | | |
| 2 | MOD2_DISABLE | 0 | R/W | When asserted modulator 2 is disabled | | | |
| 1 | MOD1_DISABLE | 0 | R/W | When asserted modulator 1 is disabled | | | |
| 0 | MOD0_DISABLE | 0 | R/W | When asserted modulator 0 is disabled | | | |

Note(s):

1. Return to the Register Map (0x40).

ENABLE Register

Figure 20: **ENABLE**

| Addr: 0x80 | | | | ENABLE |
|------------|----------|-------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit | Field | Reset | Туре | Bit Description |
| 7 | Reserved | 0 | | |
| 6 | FDEN | 0 | R/W | Flicker Detection Enable . Writing a 1 activates flicker detection. Writing a 0 disables flicker detection. |
| 5:2 | Reserved | 0 | | |
| 1 | AEN | 0 | R/W | ALS Enable . Writing a 1 enables ALS. Writing a 0 disables ALS. |
| 0 | PON | 0 | R/W | Power ON . When asserted, the internal oscillator is activated, allowing timers and modulator channels to operate. Writing a 0 disables the oscillator and clears PEN, and AEN. Only set this bit after all other registers have been initialized by the host. |

Note(s):

1. Return to the Register Map (0x80).

ams Datasheet Page 23 Document Feedback



MEAS_MODE0 Register

Figure 21: MEAS_MODE0

| | Addr: 0x81 | | MEAS_MODE0 | | | |
|-----|------------------------------------------------|-------|------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Туре | Bit Description | | |
| 7 | STOP_AFTER_NTH_ ITERATION | 0 | R/W | Stops a measurement after n th iterations by setting FDEN and AEN to 0. PON will stay at 1. Per default it stops after one measurement, which can be used for manual calibration. | | |
| 6 | ENABLE_AGC_ASAT_ DOUBLE_STEP_DOWN | 0 | R/W | Enables two gain steps down at once in case of an analogue AGC saturation and at a gain step still >0. This will allow a faster reach of 25% full-scale range and a more prompt reaction if analogue saturations occurs. | | |
| 5 | MEASUREMENT_ SEQUENCER_SINGLE_ SHOT_MODE | 0 | R/W | Start one measurement cycle with sequencer settings and stop it by asserting Sleep After Interrupt (SAI) | | |
| 4 | MOD_FIFO_ALS_STATUS_ WRITE_ENABLE | 0 | R/W | Enables writing of ALS status to the FIFO RAM in case ALS data scaling is used as well as 16-bit ALS data writing. It is needed to be able to correctly interpret the ALS data. | | |
| 3:0 | ALS_SCALE | 0x4 | R/W | ALS_SCALE is used to avoid that redundant ALS MSBs are transmitted and are reducing possible resolution, since the ALS data register is only 16 bits wide (internally the result can be 26 bits wide = 11-bit samples + 11-bit sampling time + 4-bit residuals - ALS_MSB_POSITION). The ALS_SCALE register defines the number of MSBs which must be 0 so that the scaled representation is used in the ALS data registers instead of the unscaled representation. | | |

Note(s):

1. Return to the Register Map (0x81).

Page 24ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



MEAS_MODE1 Register

Figure 22: MEAS_MODE1

| | Addr: 0x82 | | MEAS_MODE1 | | | |
|-----|---------------------------------------------|-------|------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Type | Bit Description | | |
| 7 | MOD_FIFO_FD_END_ MARKER_WRITE_ ENABLE | 0 | R/W | Enables writing of end marker to FIFO after each complete flicker measurement. | | |
| 6 | MOD_FIFO_FD_ CHECKSUM_ WRITE_ENABLE | 0 | R/W | Enables writing of flicker checksum to FIFO after each complete flicker measurement. | | |
| 5 | MOD_FIFO_FD_ GAIN_WRITE_ ENABLE | 0 | R/W | Enables writing of gain to FIFO after each complete flicker measurement. This is required in case AGC is enabled. | | |
| 4:0 | ALS_MSB_POSITION | 0x0C | R/W | Internally the result can be 26 bits wide = 11-bit samples + 11-bit sampling time + 4-bit residuals and is stored in a 32-bit register. ALS_MSB_ POSITION defines the MSB in this 32-bit register | | |

Note(s):

1. Return to the Register Map (0x82).

SAMPLE_TIME0 Register

Figure 23: SAMPLE_TIME0

| | Addr: 0x83 | | SAMPLE_TIME0 | | | |
|-----|------------------|-------|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Type | Bit Description | | |
| 7:0 | SAMPLE_TIME[7:0] | 0xB3 | R/W | Flicker sampling time and ALS measurement time step. Sets the time in steps of 1.388889µs modulator clock. The modulator clock can be divided with MOD_DIVIDER_SELECT in register CFG7. Please observe that SAMPLE_TIME needs to be set in register 0x83 and 0x84 (11-bit wide). It counts from 0-2047 (2048 counts). SAMPLE_TIME+1 = 1/FlickerSamplingTime/1.388889µs Default: 179+1 = 1/4000Hz / 1.388889µs (180 counts as counted 0-179) ALSIntegrationTimeStep = (SAMPLE_TIME+1) x 1.388889µs Default: 250µs = (179+1) x 1.388889µs | | |

Note(s):

1. Return to the Register Map (0x83).

ams DatasheetPage 25[v2-00] 2021-Nov-23Document Feedback



SAMPLE_TIME1 Register

Figure 24: SAMPLE_TIME1

| | Addr: 0x84 | | | SAMPLE_TIME1 |
|-----|-------------------|-------|------|-------------------------|
| Bit | Field | Reset | Type | Bit Description |
| 7:3 | Reserved | 0 | | |
| 2:0 | SAMPLE_TIME[10:8] | 0 | R/W | Please see SAMPLE_TIME0 |

Note(s):

1. Return to the Register Map (0x84).

ALS_NR_SAMPLESO Register

Figure 25: ALS_NR_SAMPLES0

| Addr: 0x85 | | ALS_NR_SAMPLES0 | | |
|------------|-------------------------|-----------------|------|-------------------------------------------------------------------------------------------------------------------------|
| Bit | Field | Reset | Type | Bit Description |
| 7:0 | ALS_NR_ SAMPLES[7:0] | 0 | R/W | ALS_NR_OF_SAMPLES defines the total measurement time for ALS atime = (ALS_NR_ SAMPLES+1) x (SAMPLE_TIME+1) x 1.388889µs |

Note(s):

1. Return to the Register Map (0x85).

Page 26ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



ALS_NR_SAMPLES1 Register

Figure 26: ALS_NR_SAMPLES1

| | Addr: 0x86 | | | ALS_NR_SAMPLES1 |
|-----|----------------------|-------|------|----------------------------|
| Bit | Field | Reset | Type | Bit Description |
| 7:3 | Reserved | 0 | | |
| 2:0 | ALS_NR_SAMPLES[10:8] | 0 | R/W | Please see ALS_NR_SAMPLES0 |

Note(s):

1. Return to the Register Map (0x86).

FD_NR_SAMPLESO Register

Figure 27:

FD_NR_SAMPLESO

| Addr: 0x87 | | | | FD_NR_SAMPLES0 |
|------------|--------------------|-------|------|----------------------------------------------------------------------------------------------------------------------------------|
| Bit | Field | Reset | Type | Bit Description |
| 7:0 | FD_NR_SAMPLES[7:0] | 0 | R/W | FD_NR_OF_SAMPLES defines the number of samples+1 measured in one sequencer step. The sample time is defined in SAMPLE_TIME[10:0] |

Note(s):

1. Return to the Register Map (0x87).

FD_NR_SAMPLES1 Register

Figure 28:

FD_NR_SAMPLES1

| | Addr: 0x88 | FD_NR_SAMPLES1 | | | | |
|-----|----------------------------|----------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Type | Bit Description | | |
| 7 | FD_NR_SAMPLES_ INFINITE | 0 | R/W | When asserted flicker measurement sequences will be infinitely repeated. In this mode, no end markers are inserted but results are continuously written into the FIFO. | | |
| 6:3 | Reserved | 0 | | | | |
| 2:0 | FD_NR_SAMPLES[10:8] | 0 | R/W | Please see FD_NR_SAMPLES0 | | |

Note(s):

1. Return to the Register Map (0x88).

ams Datasheet Page 27
[v2-00] 2021-Nov-23 Document Feedback



WTIME Register

Figure 29: WTIME

| Addr: 0x89 | | WTIME | | | |
|------------|-------|-------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7:0 | WTIME | 0 | R/W | Sets the WaitTime between 2 measurements of the modulator or sequencer. WTIME together with MOD_TRIGGER_TIMING (in register 0xAE TRIGGER_MODE) define the actual time between measurements. WaitTime = MOD_TRIGGER_TIMING x WTIME Default: 0 = 0 x (0+1) no WaitTime | |

Note(s):

ALS Interrupt Low Threshold Registers

Figure 30: ALS Interrupt Low Threshold

| Addr | Bit | Field | Reset | Type | Description |
|------|-----|-------|-------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0x8A | 7:0 | AILT0 | 0 | R/W | ALS Interrupt Low Threshold The ALS interrupt threshold registers are 24-bit wide. ALS |
| 0x8B | 7:0 | AILT1 | 0 | R/W | interrupt level detection compares the threshold registers |
| 0x8C | 7:0 | AILT2 | 0 | R/W | with the data accumulated by the selected modulator. The modulator can be selected via ALS_THRESHOLD_ CHANNEL. If AIEN is asserted and the accumulated data is below AILT for the number of consecutive samples specified in APERS, an interrupt is asserted on the interrupt pin (internally AINT_AILT and AINT are asserted) |

Note(s):

1. Return to the Register Map (0x8A,0x8B,0x8C).

Page 28ams DatasheetDocument Feedback[v2-00] 2021-Nov-23

^{1.} Return to the Register Map (0x89).



ALS Interrupt High Threshold Registers

Figure 31: **ALS Interrupt High Threshold**

| Addr | Bit | Field | Reset | Type | Description |
|------|-----|-------|-------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0x8D | 7:0 | AIHT0 | 0 | R/W | ALS Interrupt High Threshold The ALS interrupt threshold registers are 24-bit wide. ALS |
| 0x8E | 7:0 | AIHT1 | 0 | R/W | interrupt level detection compares the threshold registers |
| 0x8F | 7:0 | AIHT2 | 0 | R/W | with the data accumulated by the selected modulator. The modulator can be selected via ALS_THRESHOLD_ CHANNEL. If AIEN is asserted and the accumulated data is above AIHT for the number of consecutive samples specified in APERS, an interrupt is asserted on the interrupt pin (internally AINT_AIHT and AINT are asserted) |

Note(s):

1. Return to the Register Map (0x8D,0x8E,0x8F).

ams Datasheet Page 29 Document Feedback



Device Identification Registers

Figure 32:
Device Identification

| Addr | Bit | Field | Reset | Type | Description |
|------|-----|--------|-----------|------|---------------------------------------------------------------------------|
| 0x90 | 3:0 | AUX_ID | 0110b | R | Device Identification AUX_ID: Identifies package and wafer factory |
| 0x91 | 7:0 | REV_ID | 00010001b | R | REV_ID: Identifies function ID and revision |
| 0x92 | 7:0 | ID | 01011100b | R | number of CMOS die ID: Device identification |

Note(s):

1. Return to the Register Map (0x90, 0x91, 0x92).

STATUS Register

Figure 33: STATUS

| Addr: 0x93 | | | STATUS | | | |
|------------|----------|-------|--------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Type | Bit Description | | |
| 7 | MINT | 0 | R/W | Modulator Interrupt. Indicates that a modulator interrupt has occurred because of saturation. Check the STATUS2 register to differentiate between analog or digital saturation. Writing 1 to this bit clear MINT and all subsequent interrupts. | | |
| 6:4 | Reserved | 0 | | | | |
| 3 | AINT | 0 | R/W | ALS Interrupt. If AIEN is set, this interrupt indicates that an ALS event that met the programmed ALS thresholds (AILT or AIHT) and persistence (APERS) occurred. Check the STATUS3 register to differentiate. Writing 1 to this bit clear AINT and all subsequent interrupts. | | |
| 2 | FINT | 0 | R/W | FIFO Interrupt . Indicates that the data level in the FIFO met the programmed FIFO thresholds (FIFO_LVL and FIFO_THR). This interrupt is automatically asserted/removed depending on the programmed FIFO thresholds. Writing 1 to this bit clears FINT. The interrupt, however, will be promptly asserted again in case the FIFO has not been read out or cleared. | | |

Page 30ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



| Addr: 0x93 | | | STATUS | | |
|------------|----------|-------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 1 | Reserved | 0 | | | |
| 0 | SINT | 0 | | System Interrupt . If SIEN is set, indicates that one or more of several events has occurred or is complete. The events related to this interrupt are indicated in the STATUS5 register. | |

Note(s):

1. Return to the Register Map (0x93)

ALS_STATUS Register

Figure 34: ALS_STATUS

| | Addr: 0x94 | ALS_STATUS | | | |
|-----|----------------------------------------|------------|------|---------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:6 | MEAS_SEQR_STEP | 0 | R | Contains the sequencer step where ALS data was measured | |
| 5 | ALS_DATA0_ANALOG_ SATURATION_STATUS | 0 | R | Indicates analog saturation of ALS data0 in data registers ALS_ADATA0 | |
| 4 | ALS_DATA1_ANALOG_ SATURATION_STATUS | 0 | R | Indicates analog saturation of ALS data1 in data registers ALS_ADATA1 | |
| 3 | ALS_DATA2_ANALOG_ SATURATION_STATUS | 0 | R | Indicates analog saturation of ALS data2 in data registers ALS_ADATA2 | |
| 2 | ALS_DATA0_SCALED_STATUS | 0 | R | Indicates if ALS data0 needs to be multiplied if bit is set to 0: 2^(ALS_SCALED) 1: 1 | |
| 1 | ALS_DATA1_SCALED_STATUS | 0 | R | Indicates if ALS data1 needs to be multiplied if bit is set to 0: 2^(ALS_SCALED) 1: 1 | |
| 0 | ALS_DATA2_SCALED_STATUS | 0 | R | Indicates if ALS data2 needs to be multiplied if bit is set to 0: 2^(ALS_SCALED) 1: 1 | |

Note(s):

1. Return to the Register Map (0x94)

ams Datasheet Page 31
[v2-00] 2021-Nov-23
Document Feedback



ALS Data Registers

Figure 35: ALS Data Registers

| Addr | Bit | Field | Reset | Type | Description |
|------|-----|-----------------|-------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0x95 | 7:0 | ALS_DATA0[7:0] | 0 | R | ALS Data Registers. In order to update ALS Data Registers ALS_STATUS |
| 0x96 | 7:0 | ALS_DATA0[15:8] | 0 | R | must be read first. The ALS channel data is stored |
| 0x97 | 7:0 | ALS_DATA1[7:0] | 0 | R | in two 8-bit registers and shall be interpreted as 16-bit data across 2 registers. All ALS data samples |
| 0x98 | 7:0 | ALS_DATA1[15:8] | 0 | R | stored are generated in the same integration cycle. Reading these bytes consecutively (low byte |
| 0x99 | 7:0 | ALS_DATA2[7:0] | 0 | R | before high byte) ensures that the data is concurrent. The data, stored in the ALS_DATA |
| 0x9A | 7:0 | ALS_DATA2[15:8] | 0 | R | registers, is obtained from a 26-bit wide result buffer depending on settings of ALS_SCALE in MEAS_MODE0 and ALS_MSB_POSITION in MEAS_MODE1. The ALS_STATUS register indicates whether the ALS data is scaled or unscaled. In case ALS_MSB_POSITION is exceeded, data is 0xFFFE. In case of analog saturation, data is 0xFFFF. |

Note(s):

ALS_STATUS2 Register

Figure 36: ALS_STATUS2

| | Addr: 0x9B | ALS_STATUS2 | | | |
|-----|-----------------------|-------------|------|-----------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | ALS_DATA1_GAIN_STATUS | 0 | R | Contains gain for data in ALS_DATA1 registers | |
| 3:0 | ALS_DATA0_GAIN_STATUS | 0 | R | Contains gain for data in ALS_DATA0 registers | |

Note(s):

1. Return to the Register Map (0x9B).

Page 32ams DatasheetDocument Feedback[v2-00] 2021-Nov-23

^{1.} Return to the Register Map (0x95, 0x96, 0x97, 0x98, 0x99, 0x9A).



ALS_STATUS3 Register

Figure 37: ALS_STATUS3

| | Addr: 0x9C | ALS_STATUS3 | | | |
|-----|-----------------------|-------------|------|-----------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7:4 | Reserved | 0 | | | |
| 3:0 | ALS_DATA2_GAIN_STATUS | 0 | R | Contains gain for data in ALS_DATA2 registers | |

Note(s):

1. Return to the Register Map (0x9C).

STATUS2 Register

Figure 38: STATUS2

| A | Addr: 0x9D | | | STATUS2 |
|-----|--------------------------------|-------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit | Field | Reset | Туре | Bit Description |
| 7 | Reserved | 0 | R | |
| 6 | ALS_DATA_ VALID | 0 | R | ALS Data Valid. Indicates that the ALS state has completed a cycle since either an assertion of AEN or the last readout of the ASTATUS register |
| 5 | Reserved | 0 | R | |
| 4 | ALS_DIGITAL_ SATURATION | 0 | R | ALS Digital Saturation. Indicates that a counter value has been reached that cannot be expressed with the selected data format defined with ALS_MSB_POSITION. Maximum counter value also depends on integration time set in the ATIME register. |
| 3 | FD_DIGITAL_ SATURATION | 0 | R | Flicker Detect Digital Saturation. Indicates that the maximum counter value has been reached during flicker detection |
| 2 | MOD_ ANALOG_ SATURATION2 | 0 | R | ALS Analog Saturation of modulator 2. Indicates that the intensity of ambient light has exceeded the maximum integration level for the ALS analog circuit. |
| 1 | MOD_ ANALOG_ SATURATION1 | 0 | R | ALS Analog Saturation of modulator 1. Indicates that the intensity of ambient light has exceeded the maximum integration level for the ALS analog circuit. |
| 0 | MOD_ ANALOG_ SATURATION0 | 0 | R | ALS Analog Saturation of modulator 0. Indicates that the intensity of ambient light has exceeded the maximum integration level for the ALS analog circuit. |

Note(s):

1. Return to the Register Map (0x9D).

ams Datasheet Page 33
[v2-00] 2021-Nov-23
Document Feedback



STATUS3 Register

Figure 39: STATUS3

| Addr: 0x9E | | STATUS3 | | | |
|------------|---------------------------|---------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7 | AINT_HYST_ STATE_VALID | 0 | R | Indicates that the ALS interrupt hysteresis state AINT_HYST_STATE is valid. It will get asserted as soon as the value exceeds the high or the low ALS interrupt thresholds by APERS times. It is automatically cleared with AEN or PON set to 0. | |
| 6 | AINT_HYST_ STATE_RD | 0 | R | This bit indicates the state in the hysteresis defined with AINT_AILT and AINT_AIHT, Preset of state is possible before AEN is set. The contents of this register is forwarded to the INT/VSYNC_GPIO pin in case of aint interrupt direct mode. | |
| 5 | AINT_AIHT | 0 | R/W | ALS Interrupt High . Indicates that an ALS interrupt occurred because the ALS data exceeded the high threshold. Writing '1' to this bit clears this interrupt. | |
| 4 | AINT_AILT | 0 | R/W | ALS Interrupt Low. Indicates that an ALS interrupt occurred because the ALS data is below the low threshold. Writing '1' to this bit clears this interrupt. | |
| 3 | VSYNC_LOST | 1 | R | Indicates that synchronization is out of sync with clock provided at vsync pin. Default value is "1" since device always starts unsynchronized. The detected vsync clock is not within the expected range. Please see VSYNC_PERIOD_TARGET for more details. | |
| 2 | Reserved | 0 | | | |
| 1 | OSC_CALIB_ SATURATION | 0 | R | Indicates that oscillator calibration with the current values of TRIM_OSC and OSC_TUNE is out of range abs(TRIM_OSC+OSC_TUNE) > 32 | |
| 0 | OSC_CALIB_ FINISHED | 0 | R | Indicates that oscillator calibration is finished | |

Note(s):

1. Return to the Register Map (0x9E).

Page 34ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



STATUS4 Register

Figure 40: STATUS4

| Addr: 0x9F | | STATUS4 | | |
|------------|------------------------------|---------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit | Field | Reset | Туре | Bit Description |
| 7:4 | Reserved | 0 | | |
| 3 | MOD_SAMPLE_ TRIGGER_ERROR | 0 | R | Indicates that measured data is corrupted. For a valid measurement, this bit must not be asserted. This error condition does not trigger an interrupt, however AEN and FDEN will be cleared and SINT_MEASURMENT_SEQUENCER will be set. Writing "1" clears this bit. |
| 2 | MOD_TRIGGER_ ERROR | 0 | R | Indicates that WTIME is too short for the programmed configuration (SAMPLE_TIME, ALS_NR_SAMPLES, FD_NR_SMAPLES). This error condition does not trigger an interrupt. Writing "1" clears this bit. |
| 1 | SAI_ACTIVE | 0 | R | Sleep After Interrupt Active. Indicates that the device is in sleep due to an interrupt. To exit sleep mode, clear this bit by writing '1' to CLEAR_SAI_ ACTIVE. |
| 0 | INIT_BUSY | 0 | R | Initialization Busy. Indicates that the device is initializing. This bit will remain 1 for about 300µs after power on. Do not interact with the device until initialization is complete (e.g. via I ² C). |

Note(s):

1. Return to the Register Map (0x9F).

ams Datasheet Page 35 Document Feedback



STATUS5 Register

Figure 41: STATUS5

| Addr: 0xA0 | | STATUS5 | | | |
|------------|--------------------------------|---------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:2 | Reserved | 0 | | | |
| 1 | SINT_MEASUREMENT_ SEQUENCER | 0 | R/W | Indicates a measurement sequencer system interrupt in case MOD_SAMPLE_TRIGGER_ERROR occurs or after each sequencer step/round depending on the status of MEASUREMENT_SEQUENCER_SIENT_PER_STEP. In parallel SIEN_MEASUREMENT_SEQUENCER must be set. Writing '1' to this bit clears this interrupt. | |
| 0 | SINT_VSYNC | 0 | R/W | Indicates that SYNCH_LOST is set or reset. SYNCH_LOST gets set if the waiting timeout for VSYNC_TIMEOUT is reached. In parallel SIEN_VSYNC must be set. Writing '1' to this bit clears this interrupt | |

Note(s):

1. Return to the Register Map (0xA0).

CFG0 Register

Figure 42: CFG0

| Addr: 0xA1 | | CFG0 | | | |
|------------|---------------|--------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7 | Reserved | 0 | | | |
| 6 | SAI | 0 | R/W | Sleep After Interrupt. If asserted, the oscillator is turned off whenever interrupt is active (low). SAI_ ACTIVE is set in this event. To activate the oscillator again, service and clear all interrupts plus clear the SAI_ ACTIVE bit by writing "1" to CLEAR_SAI_ACTIVE. Sleep after interrupt is asserted only in combination with MEASUREMENT_SEQUENCER_SINT_PER_STEP or SIEN or SIEN_MEASUREMENT_SEQUENCER | |
| 5 | LOWPOWER_IDLE | 0 | R/W | Low Power Idle. When asserted, the device will automatically run in a low power mode whenever all functions are in wait states or disabled. | |
| 4:0 | Reserved | 01000b | R | Do not overwrite default | |

Note(s):

1. Return to the Register Map (0xA1).

Page 36ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



CFG1 Register

Figure 43: CFG1

| | Addr: 0xA2 | CFG1 | | | |
|-----|-----------------------------|------------|-----|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset Type | | Bit Description | |
| 7:3 | Reserved | 0 | | | |
| 2 | DO_ALS_FINAL_ PROCESSING | 0 | R/W | If this bit is set to "1" and flicker measurement takes longer than ALS measurement, ALS measurement writings are postponed until flicker measurement is finished. Otherwise ALS data is not written to FIFO. | |
| 1:0 | Reserved | 0 | | | |

Note(s):

1. Return to the Register Map (0xA2).

CFG2 Register

Figure 44: CFG2

| | Addr: 0xA3 | CFG2 | | | |
|-----|-------------|-------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7 | AINT_DIRECT | 0 | R/W | ALS Interrupt Direct. Enables the direct mode of ALS interrupt. ALS interrupts are only generated when ALS_DATA (selected by ALS_THRESHOLD_CHANNEL) moves over the hysteresis edges (AINT_AILT and AINT_AIHT). If bit is "0", interrupts are always generated if ALS_DATA is above AIHT or below AILT. The status of the ALS interrupt is directly output on the INT or GPIO pin if this mode is enabled and either of those pins are configured to do so according to the INT_PINMAP and VSYNC_GPIO_PINMAP settings. | |
| 6:1 | Reserved | 0 | | | |
| 0 | FIFO_THR[0] | 1 | R/W | FIFO threshold LSB. Please see FIFO_THR for information. | |

Note(s):

1. Return to the Register Map (0xA3).

ams Datasheet Page 37 **Document Feedback**



CFG3 Register

Figure 45: CFG3

| Addr: 0xA4 | | CFG3 | | | |
|------------|-------------------|-------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:6 | Reserved | 0 | | | |
| 5:4 | INT_PINMAP | 0 | R/W | Interrupt Pin Mapping. Defines internal signal which is routed to the external INT pin. 00: Default, INTERRUPT 01: AINT_HYST_STATE 10: Reserved, do not use 11: Reserved, do not use | |
| 3:2 | Reserved | 0 | | | |
| 1:0 | VSYNC_GPIO_PINMAP | 0 | R/W | Vsync/GPIO Pin Mapping. Defines internal signal which is routed to the external VSYNC/GPIO pin. 00: Default, VSYNC_GPIO_OUT 01: AINT_HYST_STATE 10: Reserved, do not use 11: Reserved, do not use | |

Note(s):

1. Return to the Register Map (0xA4).

Page 38ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



CFG4 Register

Figure 46: CFG4

| | Addr: 0xA5 | CFG4 | | | | |
|-----|------------------------------------------------------------|-------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Type | Bit Description | | |
| 7 | Reserved | 0 | | | | |
| 6 | MOD_CALIBRATION_ NTH_ITERATION_ STEP_ENABLE | 0 | R/W | Enable a modulator calibration with nth iterations per sequencer step instead of waiting for a full round for all sequencers to be finished. In case of AGC enabled (MOD_CALIB_NTH_ITERATION_AGC_ENABLE) this bit must be set "0", otherwise AGC will not properly work. | | |
| 5 | MEASUREMENT_ SEQUENCER_AGC_ PREDICT_TARGET_ LEVEL | 0 | R/W | Sets the target measurement levels for AGC prediction. 0: 50% of max value 1: 25% of max value | | |
| 4 | MEASURMENT_ SEQUENCER_ SINT_PER_STEP | 0 | R/W | Invokes the system interrupt SINT_MEASUREMENT_ SEQUENCER per sequencer step instead of after a full sequencer round. | | |
| 3 | OSC_TUNE_NO_ RESET | 0 | R/W | OSC_TUNE is set to "0" at each transition of PON from "0" to "1". If OSC_TUNE_NO_RESET is asserted, OSC_TUNE is not reset to "0". | | |
| 2 | Reserved | 0 | | | | |
| 1:0 | MOD_ALS_FIFO_ DATA_FORMAT | 0 | R/W | Sets the format for ALS data written to FIFO. Please observe readout pattern if digital or analog saturation has occurred 00: 16-bit 01: 24-bit (FFFFFF dig sat, FFFFFE analog sat) 10: Reserved 11: 32-bit (FFFFFFF dig sat, FFFFFFFE analog sat) | | |

Note(s):

1. Return to the Register Map (0xA5).

ams Datasheet Page 39
[v2-00] 2021-Nov-23
Document Feedback



CFG5 Register

Figure 47: CFG5

| | Addr: 0xA6 | | CFG5 | | | |
|-----|---------------------------|-------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Type | Bit Description | | |
| 7:6 | Reserved | 0 | | | | |
| 5:4 | ALS_THRESHOLD_ CHANNEL | 0 | R/W | Selects the modulator channel used for the ALS threshold metering and subsequent interrupt. 00: Default, modulator0 01: Modulator1 10: Modulator2 11: Modulator0 | | |
| 3:0 | APERS | 0 | R/W | ALS Interrupt Persistence. Defines a filter for the number of consecutive occurrences that ALS measurement data must remain outside the threshold range between AILT and AIHT before an interrupt is generated. The ALS data channel used for the persistence filter is set by ALS_THRESHOLD_CHANNEL. Any sample that is inside the threshold range resets the counter to 0. Interrupts are generated at 0x0: Every ALS cycle 0x1: Any ALS value outside the threshold range 0x2: 2 consecutive ALS values outside the range 0x3: 3 consecutive ALS values outside the range 0x4: 5 0x5: 10 continued in increments of 5 values 0xE: 55 0xF: 60 consecutive ALS values outside the range | | |

Note(s):

1. Return to the Register Map (0xA6).

Page 40ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



CFG6 Register

Figure 48: CFG6

| | Addr: 0xA7 | CFG6 | | | | |
|-----|--------------------------------------|-------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Туре | Bit Description | | |
| 7:6 | Reserved | 0 | | | | |
| 5 | MOD_MEASUREMENT_ COMPLETE_STARTUP | 0 | R/W | Activated complete start procedure in for each measurement sample. This reduces measurement time per sample by 9 modulator clock cycles. | | |
| 4 | Reserved | 0 | | | | |
| 3:2 | MOD_MINIMUM_ RESIDUAL_BITS | 0 | R/W | Limits the number of residual bits to a minimum within this value. ATTENTION: When this function is used, the default settings for the gains are not correct anymore. Thus a residual calibration is mandatory (use MOD_CALIB_RESIDUAL_ENABLE_AUTO_CALIB_ON_GAIN_CHANGE or MOD_CALIB_NTH_ITERATION_RC_ENABLE to enforce residual calibration) 00b: 0 residual bits at minimum (default, turned off) 01b: 1 residual bits at minimum 10b: 2 residual bits at minimum 11b: 3 residual bits at minimum | | |
| 1:0 | MOD_MAXIMUM_ RESIDUAL_BITS | 0x3 | R/W | Limits the number of residual bits to a maximum within this value. ATTENTION: When this function is used, the default settings for the gains are not correct anymore. Thus a residual calibration is mandatory (use MOD_CALIB_RESIDUAL_ENABLE_AUTO_CALIB_ON_GAIN_CHANGE or MOD_CALIB_NTH_ITERATION_RC_ENABLE to enforce residual calibration) 00b: 1 residual bits at maximum 01b: 2 residual bits at maximum 10b: 3 residual bits at maximum (default) 11b: 4 residual bits at maximum | | |

Note(s):

1. Return to the Register Map (0xA7).

Page 41 ams Datasheet **Document Feedback**



CFG7 Register

Figure 49: CFG7

| | Addr: 0xA8 | CFG7 | | | |
|-----|------------|-------|------|-----------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7:0 | Reserved | 0x01 | | | |

Note(s):

1. Return to the Register Map (0xA8).

CFG8 Register

Figure 50: CFG8

| | Addr: 0xA9 | CFG8 | | | | |
|-----|--------------------------------------------------------------|-------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Туре | Bit Description | | |
| 7:4 | MEASUREMENT_SEQUENCER_ MAX_MOD_GAIN | 0x0C | R/W | Sets the maximum gain for all channels in all sequencer steps | | |
| 3:0 | MEASUREMENT_SEQUENCER_ AGC_PREDICT_MOD_GAIN_ REDUCTION | 0x04 | R/W | Sets the modulator gain reduction in AGC predict mode. All channels in the actual measurement sequence are reduced by the programmed gain reduction before gain prediction starts. | | |

Note(s):

1. Return to the Register Map (0xA9).

CFG9 Register

Figure 51: CFG9

| | Addr: 0xAA | CFG9 | | | |
|-----|------------------------------|-------|------|----------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:2 | Reserved | 0 | | | |
| 1:0 | MOD_RESIDUAL_ BITS_IGNORE | 0 | R/W | Sets the number of residual bits ignored and shifted in flicker data. Please observe to set MOD_FD_FIFO_DATAx_WIDTH accordingly. | |

Note(s):

1. Return to the Register Map (0xAA).

Page 42ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



AGC Number of Samples Registers

Figure 52: AGC Number of Samples

| Addr | Bit | Field | Reset | Type | Description |
|------|-----|----------------------|-------|------|------------------------------------------------------------------|
| 0xAC | 7:0 | AGC_NR_SAMPLES[7:0] | 0 | R/W | AGC Number of Samples Sets the time for every AGC |
| 0xAD | 7:3 | Reserved | 0 | | measurement and is calculated as: |
| 0xAD | 2:0 | AGC_NR_SAMPLES[10:8] | 0 | R/W | agc_atime = (AGC_NR_SAMPLES+1) x (SAMPLE_TIME+1) x 1.388889µs |

Note(s):

1. Return to the Register Map (0xAC, 0xAD).

TRIGGER_MODE Register

Figure 53: TRIGGER_MODE

| Addr: 0xAE | | TRIGGER_MODE | | | |
|------------|------------------------|--------------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7:3 | Reserved | 0 | | | |
| 2:0 | MOD_TRIGGER_ TIMING | 0 | R/W | Sets the repetition rate of a modulator or sequencer measurement. Counting will immediately start or will wait for the first vsync pulse. 000: OFF 001: Normal = 2.844ms * WTIME 010: Long = 45.511ms * WTIME 011: Fast = 88.889µs * WTIME 100: Fastlong = 1.422ms * WTIME 101: vsync = One vsync per WTIME step 110: Reserved | |

Note(s):

1. Return to the Register Map (0xAE).

ams Datasheet Page 43
[v2-00] 2021-Nov-23
Document Feedback



CONTROL Register

Figure 54: CONTROL

| | Addr: 0xB1 | CONTROL | | | |
|-----|------------------|---------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7:4 | Reserved | 0 | | | |
| 3 | SOFT_RESET | 0 | R/W | Software Reset. If set and executable, the Software Reset will initialize the device in the same way as hardware reset. Prior to invoking a SOFT_RESET the oscillator must be switched on. Set PON=1. | |
| 2 | Reserved | 0 | | | |
| 1 | FIFO_CLR | 0 | R/W | Setting this bit will clear the FIFO, as well as FINT, FIFO_FULL, FIFO_OVERFLOW, FIFO_UNDERFLOW and FIFO_LVL. | |
| 0 | CLEAR_SAI_ACTIVE | 0 | R/W | Setting this bit will clear the Sleep After Interrupt Active SAI_ACTIVE and start measurements if enabled. | |

Note(s):

1. Return to the Register Map (0xB1).

Page 44ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



INTENAB Register

Figure 55: INTENAB

| Addr: 0xBA | | INTENAB | | | |
|------------|----------|---------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7 | MIEN | 0 | R/W | Modulator Interrupt Enable. Setting this bit will allow a modulator interrupt on the external INT pin. Please check in STATUS2 for the reason of the interrupt. | |
| 6:4 | Reserved | 0 | | | |
| 3 | AIEN | 0 | R/W | ALS Interrupt Enable. Setting this bit will allow an ALS interrupt on the external INT pin. Please check in STATUS3 for the reason of the interrupt. | |
| 2 | FIEN | 0 | | FIFO Interrupt Enable. Setting this bit will allow a FIFO interrupt on the external INT pin. Check FINT for further information. | |
| 1 | Reserved | 0 | | | |
| 0 | SIEN | | R/W | System Interrupt Enable. Setting this bit will allow a system interrupt on the external INT pin. Please check in STATUS3 for the reason of the interrupt. | |

Note(s):

1. Return to the Register Map (0xBA).

ams Datasheet Page 45
[v2-00] 2021-Nov-23
Document Feedback



SIEN Register

Figure 56: SIEN

| Addr: 0xBB | | SIEN | | |
|------------|--------------------------------|-------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit | Field | Reset | Туре | Bit Description |
| 7:2 | Reserved | 0 | | |
| 1 | SIEN_MEASUREMENT_ SEQUENCER | 0 | R/W | Measurement Sequencer Interrupt Enable. Setting this bit will allow a system interrupt SINT as soon as invoked by a measurement sequencer event. Please see SINT_MEASUREMENT_ SEQUENCER for further information. |
| 0 | SIEN_VSYNC | 0 | R/W | Vsync Interrupt Enable. Setting this bit will allow a system interrupt SINT as soon as a vysnc interrupt occurs. Please see SINT_VSYNC for further information. |

Note(s):

1. Return to the Register Map (0xBB).

MOD_COMP_CFG1 Register

Figure 57: MOD_COMP_CFG1

| Addr: 0xCE | | MOD_COMP_CFG1 | | | |
|------------|----------------|---------------|------|-------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:6 | MOD_IDAC_RANGE | 10b | R/W | Sets the auto zero range of the current digital-to-analog converter. 00: 58µV 01: 38µV 10: 18µV 11: 9µV | |
| 5:0 | Reserved | 0 | | | |

Note(s):

1. Return to the Register Map (0xCE).

Page 46ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



MEAS_SEQR_FD_0 Register

Figure 58: MEAS_SEQR_FD_0

| Addr: 0xCF | | MEAS_SEQR_FD_0 | | | |
|------------|-----------------------------------------------|----------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7:4 | MEASUREMENT_ SEQUENCER_MOD1_ FD_PATTERN | 0 | R/W | Defines the sequence of a flicker measurement on modulator 1. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. | |
| 3:0 | MEASUREMENT_ SEQUENCER_MOD0_ FD_PATTERN | 0x1 | R/W | Defines the sequence of a flicker measurement on modulator 0. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. By default sequencer step 0 is used on modulator 0. | |

Note(s):

MEAS_SEQR_ALS_FD_1 Register

Figure 59: MEAS_SEQR_ALS_FD_1

| Addr: 0xD0 | | MEAS_SEQR_ALS_FD_1 | | | |
|------------|-----------------------------------------------|--------------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | MEASUREMENT_ SEQUENCER_MOD2_ FD_PATTERN | 0 | R/W | Defines the sequence of a flicker measurement on modulator 2. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. | |
| 3:0 | MEASUREMENT_ SEQUENCER_ALS_ PATTERN | 0x1 | R/W | Defines the sequence of an ALS measurement on all modulators. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. By default sequencer step 0 is executed on all modulators. | |

Note(s):

ams Datasheet Page 47
[v2-00] 2021-Nov-23 Document Feedback

^{1.} Return to the Register Map (0xCF).

^{1.} Return to the Register Map (0xD0).



MEAS_SEQR_APERS_AND_VSYNC_WAIT Register

Figure 60: MEAS_SEQR_APERS_AND_VSYNC_WAIT

| | Addr: 0xD1 | MEAS_SEQR_APERS_AND_VSYNC_WAIT | | | |
|-----|--------------------------------------------------|--------------------------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | MEASUREMENT_ SEQUENCER_VSYNC_ WAIT_PATTERN | 0 | R/W | Defines if a measurement sequence shall wait for a vsync before starting the measurement. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. | |
| 3:0 | MEASUREMENT_ SEQUENCER_APERS_ PATTERN | 0x1 | R/W | Defines the sequencer steps where an ALS persistence evaluation shall be performed on modulator data selected by ALS_THRESHOLD_CHANNEL. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. By default step 0 is used on all modulators. | |

Note(s):

1. Return to the Register Map (0xD1).

MEAS_SEQR_RESIDUAL_0 Register

Figure 61: MEAS_SEQR_RESIDUAL_0

| Addr: 0xD2 | | MEAS_SEQR_RESIDUAL_0 | | | |
|------------|----------------------------------------------------------------|----------------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | MEASUREMENT_ SEQUENCER_MOD1_ RESIDUAL_ENABLE_ PATTERN | 0xF | R/W | Defines if a residual measurement on modulator 1 shall be executed. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. By default a residual measurement is done in all sequencer steps | |
| 3:0 | MEASUREMENT_ SEQUENCER_MOD0_ RESIDUAL_ENABLE_ PATTERN | 0xF | R/W | Defines if a residual measurement on modulator 0 shall be executed. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. By default a residual measurement is done in all sequencer steps | |

Note(s):

1. Return to the Register Map (0xD2).

Page 48ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



${\it MEAS_SEQR_RESIDUAL_1_AND_WAIT\ Register}$

Figure 62: ${\sf MEAS_SEQR_RESIDUAL_1_AND_WAIT}$

| Addr: 0xD3 | | | MEAS_SEQR_RESIDUAL_1_AND_WAIT | | | |
|------------|----------------------------------------------------------------|-------|-------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Туре | Bit Description | | |
| 7:4 | MEASUREMENT_ SEQUENCER_ WAIT_PATTERN | 0x1 | R/W | Defines if a sequencer step will wait for the modulator trigger timer to finish as programmed in MOD_TRIGGER_TIMING and WTIME. At the same time the timer is restarted. In case this bit is not set, the next sequencer step will start as soon as all measurements in the prior step are completed. Please observe that MOD_TRIGGER_TIMING is "0" by default. In this case the programmed wait pattern is ignored since measurement time has always priority over wait time. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. By default the wait is executed for sequencer step 3 (last sequencer step). | | |
| 3:0 | MEASUREMENT_ SEQUENCER_MOD2_ RESIDUAL_ENABLE_ PATTERN | 0xF | R/W | Defines if a residual measurement on modulator 2 shall be executed. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. By default a residual measurement is done in all sequencer steps | | |

Note(s):

1. Return to the Register Map (0xD3).

ams Datasheet Page 49 **Document Feedback**



MEAS_SEQR_STEP0_MOD_GAINX_L Register

Figure 63: MEAS_SEQR_STEP0_MOD_GAINX_L

| Addr: 0xD4 | | MEAS_SEQR_STEP0_MOD_GAINX_L | | | |
|------------|-----------------------------------------------|-----------------------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7:4 | MEASUREMENT_ SEQUENCER_STEP0_ MOD_GAIN1 | 0x8 | R/W | Defines the gain of modulator 1 for the measurement sequencer step 0. The gain is also updated by the AGC, if activated. 0x00: 1/2x 0x01: 1x 0x02: 2x 0x03: 4x 0x04: 8x 0x05: 16x 0x06: 32x 0x07: 64x 0x08: 128x 0x09: 256x 0x0A: 512x 0x0B: 1024x 0x0C: 2048x 0x0C: 2048x 0x0D: 4096x | |
| 3:0 | MEASUREMENT_ SEQUENCER_STEP0_ MOD_GAIN0 | 0x8 | R/W | Defines the gain of modulator 0 for the measurement sequencer step 0. The gain is also updated by the AGC, if activated. Gain steps see under modulator 1 above | |

Note(s):

MEAS_SEQR_STEP0_MOD_GAINX_H Register

Figure 64: MEAS_SEQR_STEP0_MOD_GAINX_H

| Addr: 0xD5 | | MEAS_SEQR_STEP0_MOD_GAINX_H | | | |
|------------|-----------------------------------------------|-----------------------------|------|--------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | Reserved | 0 | | | |
| 3:0 | MEASUREMENT_ SEQUENCER_STEP0_ MOD_GAIN2 | 0x8 | R/W | Defines the gain of modulator 2 for the measurement sequencer step 0. The gain is also updated by the AGC, if activated. | |

Note(s):

Page 50ams DatasheetDocument Feedback[v2-00] 2021-Nov-23

^{1.} Return to the Register Map (0xD4).

^{1.} Return to the Register Map (0xD5).



MEAS_SEQR_STEP1_MOD_GAINX_L Register

Figure 65: ${\tt MEAS_SEQR_STEP1_MOD_GAINX_L}$

| Addr: 0xD6 | | MEAS_SEQR_STEP1_MOD_GAINX_L | | |
|------------|-----------------------------------------------|-----------------------------|------|----------------------------------------------------------------------|
| Bit | Field | Reset | Туре | Bit Description |
| 7:4 | MEASUREMENT_ SEQUENCER_STEP1_ MOD_GAIN1 | 0x8 | R/W | Defines the gain of modulator 1 for the measurement sequencer step 1 |
| 3:0 | MEASUREMENT_ SEQUENCER_STEP1_ MOD_GAIN0 | 0x8 | R/W | Defines the gain of modulator 0 for the measurement sequencer step 1 |

Note(s):

1. Return to the Register Map (0xD6).

MEAS_SEQR_STEP1_MOD_GAINX_H Register

Figure 66: ${\tt MEAS_SEQR_STEP1_MOD_GAINX_H}$

| Addr: 0xD7 | | MEAS_SEQR_STEP1_MOD_GAINX_H | | | |
|------------|-----------------------------------------------|-----------------------------|------|----------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | Reserved | 0 | | | |
| 3:0 | MEASUREMENT_ SEQUENCER_STEP1_ MOD_GAIN2 | 0x8 | R/W | Defines the gain of modulator 2 for the measurement sequencer step 1 | |

Note(s):

1. Return to the Register Map (0xD7).

ams Datasheet Page 51 **Document Feedback**



MEAS_SEQR_STEP2_MOD_GAINX_L Register

Figure 67: MEAS_SEQR_STEP2_MOD_GAINX_L

| Addr: 0xD8 | | MEAS_SEQR_STEP2_MOD_GAINX_L | | |
|------------|-----------------------------------------------|-----------------------------|------|----------------------------------------------------------------------|
| Bit | Field | Reset | Туре | Bit Description |
| 7:4 | MEASUREMENT_ SEQUENCER_STEP2_ MOD_GAIN1 | 0x8 | R/W | Defines the gain of modulator 1 for the measurement sequencer step 2 |
| 3:0 | MEASUREMENT_ SEQUENCER_STEP2_ MOD_GAIN0 | 0x8 | R/W | Defines the gain of modulator 0 for the measurement sequencer step 2 |

Note(s):

1. Return to the Register Map (0xD8).

MEAS_SEQR_STEP2_MOD_GAINX_H Register

Figure 68:

 ${\sf MEAS_SEQR_STEP2_MOD_GAINX_H}$

| Addr: 0xD9 | | MEAS_SEQR_STEP2_MOD_GAINX_H | | | |
|------------|-----------------------------------------------|-----------------------------|------|----------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7:4 | Reserved | 0 | | | |
| 3:0 | MEASUREMENT_ SEQUENCER_STEP2_ MOD_GAIN2 | 0x8 | R/W | Defines the gain of modulator 2 for the measurement sequencer step 2 | |

Note(s):

1. Return to the Register Map (0xD9).

Page 52ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



MEAS_SEQR_STEP3_MOD_GAINX_L Register

Figure 69:

 ${\sf MEAS_SEQR_STEP3_MOD_GAINX_L}$

| Addr: 0xDA | | MEAS_SEQR_STEP3_MOD_GAINX_L | | |
|------------|-----------------------------------------------|-----------------------------|------|----------------------------------------------------------------------|
| Bit | Field | Reset | Туре | Bit Description |
| 7:4 | MEASUREMENT_ SEQUENCER_STEP3_ MOD_GAIN1 | 0x8 | R/W | Defines the gain of modulator 1 for the measurement sequencer step 3 |
| 3:0 | MEASUREMENT_ SEQUENCER_STEP3_ MOD_GAIN0 | 0x8 | R/W | Defines the gain of modulator 0 for the measurement sequencer step 3 |

Note(s):

1. Return to the Register Map (0xDA).

MEAS_SEQR_STEP3_MOD_GAINX_H Register

Figure 70:

 ${\sf MEAS_SEQR_STEP3_MOD_GAINX_H}$

| Addr: 0xDB | | MEAS_SEQR_STEP3_MOD_GAINX_H | | | |
|------------|-----------------------------------------------|-----------------------------|------|----------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | Reserved | 0 | | | |
| 3:0 | MEASUREMENT_ SEQUENCER_STEP3_ MOD_GAIN2 | 0x8 | R/W | Defines the gain of modulator 2 for the measurement sequencer step 3 | |

Note(s):

1. Return to the Register Map (0xDB).

ams Datasheet Page 53 **Document Feedback**



${\it MEAS_SEQR_STEP0_MOD_PHDX_SMUX_L}\ Register$

Figure 71: MEAS_SEQR_STEP0_MOD_PHDX_SMUX_L

| Addr: 0xDC | | MEAS_SEQR_STEP0_MOD_PHDX_SMUX_L | | | | |
|------------|---------------------------------------------------|---------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Туре | Bit Description | | |
| 7:6 | MEASUREMENT_ SEQUENCER_STEP0_ MOD_PHD3_SMUX | 01b | R/W | Defines connection of photodiode 3 to modulator for sequencer step 0 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | | |
| 5:4 | MEASUREMENT_ SEQUENCER_STEP0_ MOD_PHD2_SMUX | 10b | R/W | Defines connection of photodiode 2 to modulator for sequencer step 0 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | | |
| 3:2 | MEASUREMENT_ SEQUENCER_STEP0_ MOD_PHD1_SMUX | 01b | R/W | Defines connection of photodiode 1 to modulator for sequencer step 0 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | | |
| 1:0 | MEASUREMENT_ SEQUENCER_STEP0_ MOD_PHD0_SMUX | 10b | R/W | Defines connection of photodiode 0 to modulator for sequencer step 0 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | | |

Note(s):

1. Return to the Register Map (0xDC).

Page 54ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



$MEAS_SEQR_STEP0_MOD_PHDX_SMUX_H$ Register

Figure 72: MEAS_SEQR_STEP0_MOD_PHDX_SMUX_H

| Addr: 0xDD | | MEAS_SEQR_STEP0_MOD_PHDX_SMUX_H | | | |
|------------|---------------------------------------------------|---------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | Reserved | 0 | | | |
| 3:2 | MEASUREMENT_ SEQUENCER_STEP0_ MOD_PHD5_SMUX | 01b | R/W | Defines connection of photodiode 5 to modulator for sequencer step 0 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 1:0 | MEASUREMENT_ SEQUENCER_STEP0_ MOD_PHD4_SMUX | 10b | R/W | Defines connection of photodiode 4 to modulator for sequencer step 0 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |

Note(s):

1. Return to the Register Map (0xDD).

ams Datasheet Page 55
[v2-00] 2021-Nov-23
Document Feedback



$MEAS_SEQR_STEP1_MOD_PHDX_SMUX_L$ Register

Figure 73: MEAS_SEQR_STEP1_MOD_PHDX_SMUX_L

| Addr: 0xDE | | MEAS_SEQR_STEP1_MOD_PHDX_SMUX_L | | | |
|------------|---------------------------------------------------|---------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:6 | MEASUREMENT_ SEQUENCER_STEP1_ MOD_PHD3_SMUX | 10b | R/W | Defines connection of photodiode 3 to modulator for sequencer step 1 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 5:4 | MEASUREMENT_ SEQUENCER_STEP1_ MOD_PHD2_SMUX | 00b | R/W | Defines connection of photodiode 2 to modulator for sequencer step 1 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 3:2 | MEASUREMENT_ SEQUENCER_STEP1_ MOD_PHD1_SMUX | 01b | R/W | Defines connection of photodiode 1 to modulator for sequencer step 1 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 1:0 | MEASUREMENT_ SEQUENCER_STEP1_ MOD_PHD0_SMUX | 00b | R/W | Defines connection of photodiode 0 to modulator for sequencer step 1 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |

Note(s):

1. Return to the Register Map (0xDE).

Page 56ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



MEAS_SEQR_STEP1_MOD_PHDX_SMUX_H Register

Figure 74: ${\sf MEAS_SEQR_STEP1_MOD_PHDX_SMUX_H}$

| Addr: 0xDF | | MEAS_SEQR_STEP1_MOD_PHDX_SMUX_H | | | |
|------------|---------------------------------------------------|---------------------------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | MEASUREMENT_ SEQUENCER_AGC_ ASAT_PATTERN | 1111b | R/W | Defines the sequencer steps where analog saturation AGC is enabled for the corresponding measurement. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. By default this feature is enabled for all sequencer steps. | |
| 3:2 | MEASUREMENT_ SEQUENCER_STEP1_ MOD_PHD5_SMUX | 00b | R/W | Defines connection of photodiode 5 to modulator for sequencer step 1 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 1:0 | MEASUREMENT_ SEQUENCER_STEP1_ MOD_PHD4_SMUX | 11b | R/W | Defines connection of photodiode 4 to modulator for sequencer step 1 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |

Note(s):

1. Return to the Register Map (0xDF).

ams Datasheet Page 57 **Document Feedback**



$MEAS_SEQR_STEP2_MOD_PHDX_SMUX_L$ Register

Figure 75: MEAS_SEQR_STEP2_MOD_PHDX_SMUX_L

| Addr: 0xE0 | | MEAS_SEQR_STEP2_MOD_PHDX_SMUX_L | | | |
|------------|---------------------------------------------------|---------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:6 | MEASUREMENT_ SEQUENCER_STEP2_ MOD_PHD3_SMUX | 00b | R/W | Defines connection of photodiode 3 to modulator for sequencer step 2 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 5:4 | MEASUREMENT_ SEQUENCER_STEP2_ MOD_PHD2_SMUX | 00b | R/W | Defines connection of photodiode 2 to modulator for sequencer step 2 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 3:2 | MEASUREMENT_ SEQUENCER_STEP2_ MOD_PHD1_SMUX | 01b | R/W | Defines connection of photodiode 1 to modulator for sequencer step 2 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 1:0 | MEASUREMENT_ SEQUENCER_STEP2_ MOD_PHD0_SMUX | 11b | R/W | Defines connection of photodiode 0 to modulator for sequencer step 2 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |

Note(s):

1. Return to the Register Map (0xE0).

Page 58ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



$MEAS_SEQR_STEP2_MOD_PHDX_SMUX_H$ Register

Figure 76: ${\sf MEAS_SEQR_STEP2_MOD_PHDX_SMUX_H}$

| | Addr: 0xE1 | | MEAS_SEQR_STEP2_MOD_PHDX_SMUX_H | | | |
|-----|---------------------------------------------------|-------|---------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Туре | Bit Description | | |
| 7:4 | MEASUREMENT_ SEQUENCER_AGC_ PREDICT_PATTERN | 1111b | R/W | Defines the sequencer steps where predict AGC is enabled for the corresponding measurement. The bit pattern does not represent a value but controls bitwise which sequencer step shall be used. The leftmost position of "0000" refers to sequencer step 3, the rightmost refers to sequencer step 0. By default this feature is enabled for all sequencer steps. | | |
| 3:2 | MEASUREMENT_ SEQUENCER_STEP2_ MOD_PHD5_SMUX | 10b | R/W | Defines connection of photodiode 5 to modulator for sequencer step 2 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | | |
| 1:0 | MEASUREMENT_ SEQUENCER_STEP2_ MOD_PHD4_SMUX | 00b | R/W | Defines connection of photodiode 4 to modulator for sequencer step 2 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | | |

Note(s):

1. Return to the Register Map (0xE1).

ams Datasheet Page 59 **Document Feedback**



$MEAS_SEQR_STEP3_MOD_PHDX_SMUX_L$ Register

Figure 77: MEAS_SEQR_STEP3_MOD_PHDX_SMUX_L

| Addr: 0xE2 | | MEAS_SEQR_STEP3_MOD_PHDX_SMUX_L | | | |
|------------|---------------------------------------------------|---------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:6 | MEASUREMENT_ SEQUENCER_STEP3_ MOD_PHD3_SMUX | 00b | R/W | Defines connection of photodiode 3 to modulator for sequencer step 3 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 5:4 | MEASUREMENT_ SEQUENCER_STEP3_ MOD_PHD2_SMUX | 10b | R/W | Defines connection of photodiode 2 to modulator for sequencer step 3 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 3:2 | MEASUREMENT_ SEQUENCER_STEP3_ MOD_PHD1_SMUX | 01b | R/W | Defines connection of photodiode 1 to modulator for sequencer step 3 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 1:0 | MEASUREMENT_ SEQUENCER_STEP3_ MOD_PHD0_SMUX | 00b | R/W | Defines connection of photodiode 0 to modulator for sequencer step 3 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |

Note(s):

1. Return to the Register Map (0xE2).

Page 60ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



MEAS_SEQR_STEP3_MOD_PHDX_SMUX_H Register

Figure 78: MEAS_SEQR_STEP3_MOD_PHDX_SMUX_H

| Addr: 0xE3 | | MEAS_SEQR_STEP3_MOD_PHDX_SMUX_H | | | |
|------------|---------------------------------------------------|---------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:4 | Reserved | 0000b | | | |
| 3:2 | MEASUREMENT_ SEQUENCER_STEP3_ MOD_PHD5_SMUX | 00b | R/W | Defines connection of photodiode 5 to modulator for sequencer step 3 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |
| 1:0 | MEASUREMENT_ SEQUENCER_STEP3_ MOD_PHD4_SMUX | 11b | R/W | Defines connection of photodiode 4 to modulator for sequencer step 3 00: No connection 01: Modulator 0 10: Modulator 1 11: Modulator 2 | |

Note(s):

1. Return to the Register Map (0xE3).

MOD_CALIB_CFG0 Register

Figure 79: MOD_CALIB_CFG0

| Addr: 0xE4 | | MOD_CALIB_CFG0 | | | |
|------------|------------------------------|----------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:0 | MODE_CALIB_NTH_ ITERATION | 0xFF | R/W | Defines the repetition rate of calibrations in sequencer rounds or steps depending on MOD_CALIB_NTH_ITERATION_STEP_ENABLE. 0x00: Never 0x01-0xFE: Every n th time 0xFF: Only once at start | |

Note(s):

1. Return to the Register Map (0xE4).

ams Datasheet Page 61 **Document Feedback**



MOD_CALIB_CFG2 Register

Figure 80: $\mathsf{MOD_CALIB_CFG2}$

| | Addr: 0xE6 | MOD_CALIB_CFG2 | | | | |
|-----|-----------------------------------------------------------------|----------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Туре | Bit Description | | |
| 7 | MOD_CALIB_NTH_ ITERATION_RC_ ENABLE | 1 | R/W | Enables a residual calibration during the n th iteration. Please observe that this residual calibration feature only makes sense for modulators which are enabled in the first sequences step, since a gain calibration only happens in the first sequencer step. | | |
| 6 | MOD_CALIB_NTH_ ITERATION_AZ_ ENABLE | 1 | R/W | Enables auto-zero calibration during the n th iteration. | | |
| 5 | MOD_CALIB_NTH_ ITERATION_AGC_ ENABLE | 0 | R/W | Enables AGC calibration during the n th iteration. Please observe in this case, that MOD_CALIB_NTH_ ITERATION_STEP_ENABLE must be "0" otherwise AGC will not be properly executed. | | |
| 4 | MOD_CALIB_ RESIDUAL_ENABLE_ AUTO_CALIB_ON_ GAIN_CHANGE | 1 | R/W | Enables an automatic re-calibration in case of a change in gain. This re-calibration is executed at the beginning of each sequencer step. | | |
| 3:0 | Reserved | 0x3 | | | | |

Note(s):

1. Return to the Register Map (0xE6).

Page 62 ams Datasheet [v2-00] 2021-Nov-23



VSYNC Period Registers

Figure 81: **VSYNC Period**

| Addr | Bit | Field | Reset | Type | Description |
|------|-----|--------------------|-------|------|----------------------------------------------------------------------|
| 0xF2 | 7:0 | VSYNC_PERIOD[7:0] | 0 | R/W | VSYNC Period Contains the measured VSYNC in |
| 0xF3 | 7:0 | VSYNC_PERIOD[15:8] | 0 | R/W | multiples of 1.3888µs Reading this register clears HOLD_VSYNC_PERIOD |

Note(s):

1. Return to the Register Map (0xF2, 0xF3).

VSYNC Period Target Registers

Figure 82:

VSYNC Period Target

| Addr | Bit | Field | Reset | Туре | Description |
|------|-----|---------------------------|-------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0xF4 | 7:0 | VSYNC_PERIOD_TARGET[7:0] | 0 | R/W | VSYNC Period Target Defines the target range for the VSYNC_ |
| 0xF5 | 6:0 | VSYNC_PERIOD_TARGET[14:8] | 0 | R/W | PERIOD between VSYNC_PERIOD_ TARGET =(1/vsync [in Hz])/1.38889µs e.g. for 60Hz = 0x2EDF Attention: Will cause malfunction/overflow if not properly set. |

Note(s):

1. Return to the Register Map (0xF4, 0xF5).

VSYNC_PERIOD_TARGET Register

Figure 83:

VSYNC_PERIOD_TARGET

| Addr: 0xF5 | | VSYNC_PERIOD_TARGET | | | |
|------------|---------------------------------------|---------------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7 | VSYNC_PERIOD_USE_ FAST_TIMING_EVAL | 0 | R/W | If set to "0" the vsync target shall match VSYNC_ PERIOD[15:1] which ranges from 15Hz to 500Hz. If set to "1" the vsync target shall match VSYNC_ PERIOD[14:0] which ranges from 30Hz to 1000Hz. | |

Note(s):

1. Return to the Register Map (0xF5).

ams Datasheet Page 63 **Document Feedback**



VSYNC_CONTROL Register

Figure 84: VSYNC_CONTROL

| | Addr: 0xF6 | VSYNC_CONTROL | | | |
|-----|-------------------|---------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7:2 | Reserved | 0 | | | |
| 1 | HOLD_VSYNC_PERIOD | 0 | R/W | If set to "1" VSYNC_PERIOD[15:8] and VSYNC_ PERIOD[7:0] cannot be updated until VSYNC_ PERIOD[15:8] has been read. It will avoid that updates during I ² C readings. | |
| 0 | SW_VSYNC_TRIGGER | 0 | R/W | If VSYNC_MODE is set to "1", this bit can be used to trigger a SW sync. In case the exact time is known between two consecutive I ² C reading the offset of the oscillator frequency can be calculated from the result in VSYNC_TRIGGER | |

Note(s):

1. Return to the Register Map (0xF6).

Page 64ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



VSYNC_CFG Register

Figure 85: VSYNC_CFG

| Addr: 0xF7 | | VSYNC_CFG | | | | |
|------------|----------------|-----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Туре | Bit Description | | |
| 7:6 | OSC_CALIB_MODE | 0 | R/W | Oscillator Calibration Mode Register 00: Osc cal disabled 01: Osc cal after PON, if PON goes to "1" or after each VSYNC_LOST goes to "0" an oscillator calibration is performed if no measurement cycle is active 10: Osc cal always on, an oscillator calibration is permanently performed if no measurement cycle is active and no VSYNC_LOST is set. 11: Reserved, do not use | | |
| 5:3 | Reserved | 0 | | | | |
| 2 | VSYNC_MODE | 0 | R/W | Determines which VSYNC signal is used as a trigger 0: Use the external pin signal from VSYNC/GPIO/INT as a trigger 1: Use SW_VSYNC_TRIGGER as a trigger | | |
| 1 | VSYNC_SELECT | 0 | R/W | Determines whether the external VSYNC/GPIO pin or the INT pin is used a trigger signal 0: VSYNC/GPIO 1: INT | | |
| 0 | VSYNC_INVERT | 0 | R/W | If set to "1" the vsync input signal is inverted | | |

Note(s):

1. Return to the Register Map (0xF7).

ams Datasheet Page 65 **Document Feedback**



VSYNC_GPIO_INT Register

Figure 86: VSYNC_GPIO_INT

| | Addr: 0xF8 | VSYNC_GPIO_INT | | | | |
|-----|-------------------|----------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Bit | Field | Reset | Type | Bit Description | | |
| 7 | Reserved | 0 | | | | |
| 6 | INT_INVERT | 0 | R/W | If set to "1" the INT pin output is inverted. This applies to all output signals as selected in INT_PINMAP | | |
| 5 | INT_IN_EN | 0 | R/W | If programmed to "1" the INT pin is set as input. Please observe that the connected net must not be floating since INT is an open drain input | | |
| 4 | INT_IN | 0 | R | External HIGH or LO value applied to INT pin | | |
| 3 | VSYNC_GPIO_INVERT | 0 | R/W | If set to "1" the VSYNC/GPIO pin output is inverted. This applies to all output signals as selected in VSYNC_GPIO_PINMAP | | |
| 2 | VSYNC_GPIO_IN_EN | 0 | R/W | If programmed to "1" the VSYNC/GPIO pin is set as input. Please observe that the connected net must not be floating since VSYNC/GPIO is an open drain input | | |
| 1 | VSYNC_GPIO_OUT | 1 | R/W | Programs the VSYNC/GPIO pin HI or LOW. Since the pin is an open drain I/O pin, the default value is HIGH to avoid any unintended power consumption through pull-up resistor. The routed internal signal is selected in VSYNC_GPIO_PINMAP. | | |
| 0 | VSYNC_GPIO_IN | 0 | R | External HIGH or LO value applied to VSYNC/GPIO pin | | |

Note(s):

1. Return to the Register Map (0xF8).

Page 66ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



MOD_FIFO_DATA_CFG0 Register

Figure 87: MOD_FIFO_DATA_CFG0

| | Addr: 0xF9 | | MOD_FIFO_DATA_CFG0 | | |
|-----|------------------------------------------|-------|--------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7 | MOD_ALS_FIFO_DATA0_ WRITE_ENABLE | 1 | R/W | Enables to write data of modulator 0 into the FIFO under the following conditions: Flicker measurement is disabled in the sequencer step or flicker measurement has been finished (ALS_NR_SAMPLES >= FD_NR_SAMPLES) In case (ALS_NR_SAMPLES < FD_NR_SAMPLES) then DO_ALS_FINAL_PROCESSING_AFTER_FLICKER must be set to "1" | |
| 6 | Reserved | 0 | | | |
| 5 | MOD_FD_FIFO_DATA0_ COMPRESSION_ENABLE | 0 | R/W | Enables data compression in case of flicker measurements | |
| 4 | MOD_FD_FIFO_DATA0_ DIFFERENCE_ENABLE | 0 | R/W | If set, only the delta value between two consecutive samples is written into FIFO. The setting makes only sense in combination with enabled data compression (MOD_FD_FIFO_DATAO_COMPRESSION_ENABLE) | |
| 3:0 | MOD_FD_FIFO_ DATA0_WIDTH | 0xF | R/W | Defines absolute number of bits from a sample written to FIFO E.g. if set to 10, 11 bits (0-10) are written into the FIFO. | |

Note(s):

1. Return to the Register Map (0xF9).

ams Datasheet Page 67 **Document Feedback**



MOD_FIFO_DATA_CFG1 Register

Figure 88: MOD_FIFO_DATA_CFG1

| | Addr: 0xFA | | MOD_FIFO_DATA_CFG1 | | |
|-----|------------------------------------------|-------|--------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Type | Bit Description | |
| 7 | MOD_ALS_FIFO_DATA1_ WRITE_ENABLE | 1 | R/W | Enables to write data of modulator 1 into the FIFO under the following conditions: Flicker measurement is disabled in the sequencer step or flicker measurement has been finished (ALS_NR_SAMPLES >= FD_NR_SAMPLES) In case (ALS_NR_SAMPLES < FD_NR_SAMPLES) then DO_ALS_FINAL_PROCESSING_AFTER_FLICKER must be set to "1" | |
| 6 | Reserved | 0 | | | |
| 5 | MOD_FD_FIFO_DATA1_ COMPRESSION_ENABLE | 0 | R/W | Enables data compression in case of flicker measurements | |
| 4 | MOD_FD_FIFO_DATA1_ DIFFERENCE_ENABLE | 0 | R/W | If set, only the delta value between two consecutive samples is written into FIFO. The setting makes only sense in combination with enabled data compression (MOD_FD_FIFO_DATA1_ COMPRESSION_ENABLE) | |
| 3:0 | MOD_FD_FIFO_ DATA1_WIDTH | 0xF | R/W | Defines absolute number of bits from a sample written to FIFO E.g. if set to 10, 11 bits (0-10) are written into the FIFO | |

Note(s):

1. Return to the Register Map (0xFA).

Page 68ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



MOD_FIFO_DATA_CFG2 Register

Figure 89: MOD_FIFO_DATA_CFG2

| | Addr: 0xFB | | MOD_FIFO_DATA_CFG2 | | | | |
|-----|------------------------------------------|-------|--------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|
| Bit | Field | Reset | Туре | Bit Description | | | |
| 7 | MOD_ALS_FIFO_DATA2_ WRITE_ENABLE | 1 | R/W | Enables to write data of modulator 2 into the FIFO under the following conditions: Flicker measurement is disabled in the sequencer step or In case (ALS_NR_SAMPLES < FD_NR_SAMPLES) then flicker measurement has been finished (ALS_NR_SAMPLES >= FD_NR_SAMPLES) DO_ALS_FINAL_PROCESSING_AFTER_FLICKER must be set to "1" | | | |
| 6 | Reserved | 0 | | | | | |
| 5 | MOD_FD_FIFO_DATA2_ COMPRESSION_ENABLE | 0 | R/W | Enables data compression in case of flicker measurements | | | |
| 4 | MOD_FD_FIFO_DATA2_ DIFFERENCE_ENABLE | 0 | R/W | If set, only the delta value between two consecutive samples is written into FIFO. The setting makes only sense in combination with enabled data compression (MOD_FD_FIFO_DATA2_COMPRESSION_ENABLE). | | | |
| 3:0 | MOD_FD_FIFO_ DATA2_WIDTH | 0xF | R/W | Defines absolute number of bits from a sample written to FIFO E.g. if set to 10, 11 bits (0-10) are written into the FIFO. | | | |

Note(s):

1. Return to the Register Map (0xFB).

FIFO_THR Register

Figure 90: FIFO_THR

| Addr: 0xFC | | FIFO_THR | | |
|------------|---------------|----------|------|----------------------------------------------------------|
| Bit | Field | Reset | Type | Bit Description |
| 7:0 | FIFO_THR[8:1] | 0x7F | R/W | If FIFO_LVL > FIFO_THR a FIFO interrupt FINT is invoked. |

Note(s):

1. Return to the Register Map (0xFC).

ams Datasheet Page 69 **Document Feedback**



FIFO Level Registers

Figure 91: FIFO Level

| Addr | Bit | Field | Reset | Type | Description |
|------|-----|---------------|-------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0xFD | 7:0 | FIFO_LVL[9:2] | 0 | R | FIFO Status 0 Contains the number of 1-byte FIFO |
| 0xFE | 1:0 | FIFO_LVL[1:0] | 0 | R | entries. The size of the FIFO is 512x8. Thus FIFO_LVL ranges between 0 (empty) and 512 (full). Always read FIFO_LVL and flags in FIFO_STATUS1 one after the other to receive correct FIFO status information. |

Note(s):

1. Return to the Register Map (0xFD, 0xFE).

FIFO_STATUSO Registers

Figure 92: FIFO_STATUS0

| | Addr: 0xFE | FIFO_STATUS0 | | | |
|-----|----------------|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Field | Reset | Туре | Bit Description | |
| 7 | FIFO_OVERFLOW | 0 | R | If set to "1" a FIFO overflow has occurred and data for the FIFO was lost (e.g. reading from FIFO was too slow). This flag is cleared by PON and FIFO_CLR. Always check this flag before and after reading the FIFO. | |
| 6 | FIFO_UNDERFLOW | 0 | R | If set to "1" the FIFO was read out too often and has returned 0 at least once. In such case the read-out data may not consistent anymore. This flag is cleared by PON and FIFO_CLR. Always check this flag before and after reading the FIFO. | |
| 5:2 | Reserved | 0 | | | |
| 1:0 | FIFO_LVL[1:0] | 0 | R | See FIFO Status 0 for description | |

Note(s):

1. Return to the Register Map (0xFE).

Page 70ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



FIFO_DATA Registers

Figure 93: FIFO_DATA

| | Addr: 0xFF | FIFO_DATA | | |
|-----|------------|-----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit | Field | Reset | Type | Bit Description |
| 7:0 | FIFO_DATA | 0 | R | The register FIFO_DATA can be read-out with single reads or with a block-read. Upon reading out FIFO_DATA, the internal FIFO read pointer is advanced and FIFO_LVL is decreased. A false reading upon the FIFO_LVL will return 0 and set the FIFO_UNDERFLOW flag. |

Note(s):

1. Return to the Register Map (0xFF).

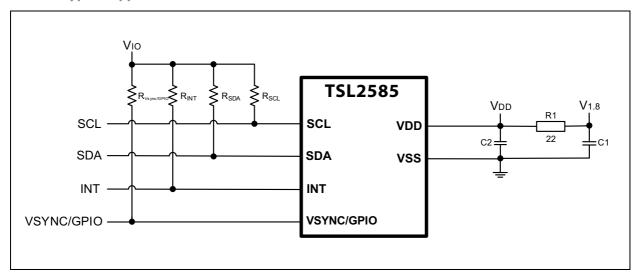
ams Datasheet Page 71 Document Feedback



Application Information

It is highly recommended to consult the **ams** application team for circuit diagram and layout review at design-in.

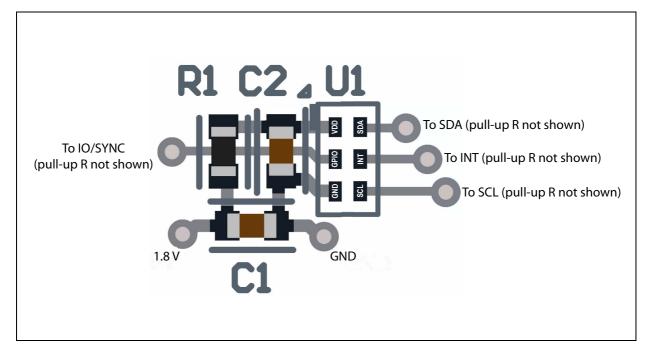
Figure 94: TSL2585 Typical Application Circuit



Note(s):

1. C1 in the graphic above shall be 4.7μ F, 6.3V, 10% and C2 in the graphic above shall be 1μ F, 6.3V, 20%. All ground vias shall be connected to a solid ground plane.

Figure 95: TSL2585 Recommended Part Placement



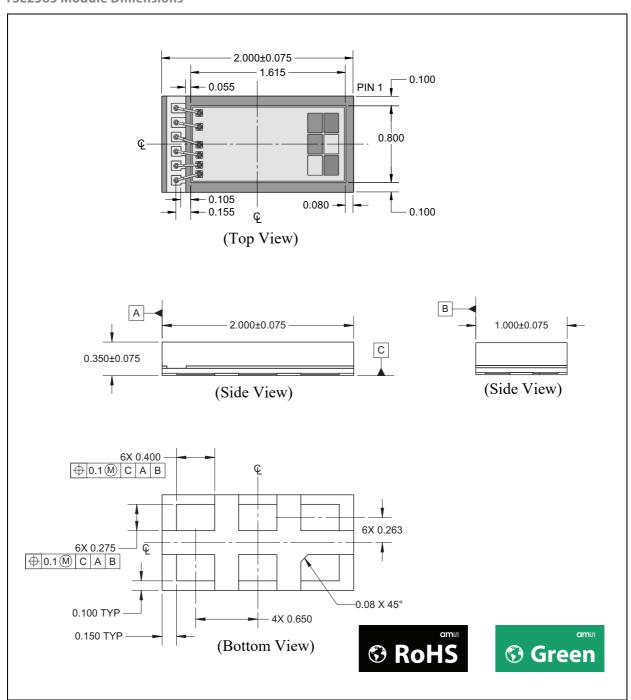
Page 72

Document Feedback [v2-00] 2021-Nov-23



Package Drawings & Markings

Figure 96: **TSL2585 Module Dimensions**



Note(s):

- 1. All linear dimensions are in millimeters.
- 2. The die is centered within the package within a tolerance of ± 75 micrometers.
- 3. Dimension tolerances are ±0.05mm unless otherwise noted
- 4. Package top surface is molded with an electrically nonconductive clear plastic compound having an index of refraction of 1.55.
- 5. Contact finish is copper alloy A194 with pre-plated NiPdAu lead finish (ENEPIG).
- 6. This package contains no lead (Pb).
- 7. This drawing is subject to change without notice.

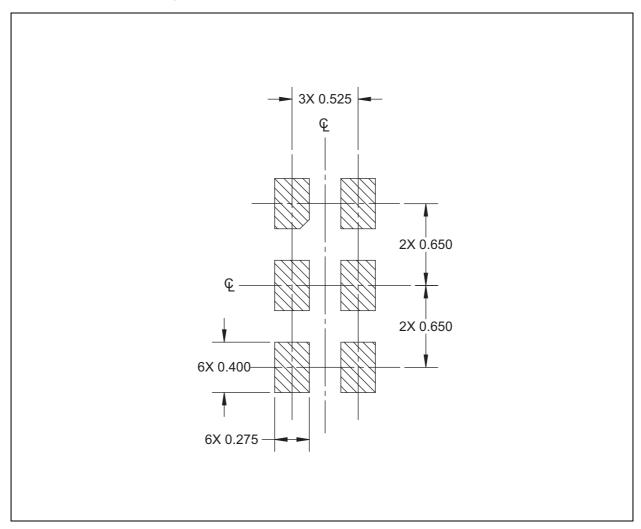
ams Datasheet Page 73



PCB Pad Layout

Suggested PCB pad layout guidelines for the surface mount module are shown. Flash Gold is recommended as a surface finish for the landing pads.

Figure 97: Recommended PCB Pad Layout



Note(s):

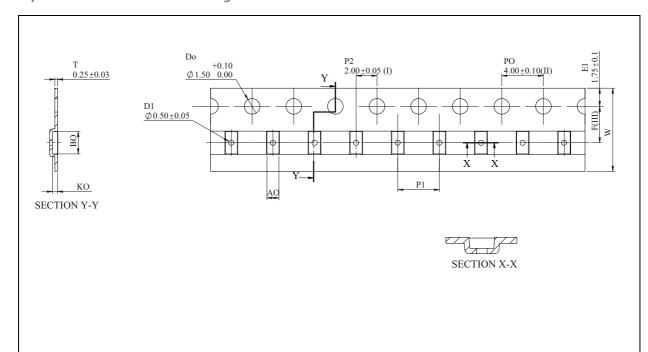
- 1. All linear dimensions are in millimeters.
- 2. Dimension tolerances are $\pm 0.05 mm$ unless otherwise noted.
- 3. This drawing is subject to change without notice.

Page 74ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



Tape & Reel Information

Figure 98:
Tape and Reel Mechanical Drawing



| Ao | 1.15 | +/- 0.05 |
|----|------|----------|
| Во | 2.15 | +/- 0.05 |
| Ko | 0.50 | +/- 0.05 |
| F | 3.50 | +/- 0.05 |
| P1 | 4.00 | +/- 0.10 |
| W | 8.00 | +/- 0.10 |

- (I) Measured from centreline of sprocket hole to centreline of pocket.
- (II) Cumulative tolerance of 10 sprocket holes is ± 0.20 .
- (III) Measured from centreline of sprocket hole to centreline of pocket.
- (IV) Other material available.

Note(s):

- 1. All linear dimensions are in millimeters. Dimension tolerance is ± 0.10 mm unless otherwise noted.
- 2. The dimensions on this drawing are for illustrative purposes only. Dimensions of an actual carrier may vary slightly.
- 3. Symbols on drawing Ao, Bo, and Ko are defined in ANSI EIA Standard 481-B 2001.
- 4. ams packaging tape and reel conform to the requirements of EIA Standard 481-B.
- 5. In accordance with EIA standard device pin 1 is located next to the sprocket holes in the tape.
- 6. This drawing is subject to change without notice.

ams Datasheet Page 75
[v2-00] 2021-Nov-23
Document Feedback



Soldering & Storage Information

Soldering Information

The module has been tested and has demonstrated an ability to be reflow soldered to a PCB substrate. The solder reflow profile describes the expected maximum heat exposure of components during the solder reflow process of product on a PCB. Temperature is measured on top of component. The components should be limited to a maximum of three passes through this solder reflow profile.

Figure 99: Solder Reflow Profile

| Profile Feature Preheat/Soak | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|-----------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Temperature Min (T _{smin}) | 100°C | 150°C |
| Temperature Max (T _{smax}) | 150°C | 200°C |
| Time (t _s) from (T _{smin} to T _{smax}) | 60-120 seconds | 60-120 seconds |
| Ramp-up rate (T _L to T _P) | 3°C/second max. | 3°C/second max. |
| Liquidous temperature (T_L) Time (t_L) maintained above T_L | 183°C 60-150 seconds | 217°C 60-150 seconds |
| Peak package body temperature (T _P) | For users T _P must not exceed the Classification temp of 235°C For suppliers T _P must equal or exceed the Classification temp of 235°C | For users T _P must not exceed the Classification temp of 260°C For suppliers T _P must equal or exceed the Classification temp of 260°C |
| Time $(t_p)^{(1)}$ within 5°C of the specified classification temperature (T_c) | 20 ⁽¹⁾ seconds | 30 ⁽¹⁾ seconds |
| Ramp-down rate (T _P to T _L) | 6°C/second max. | 6°C/second max. |
| Time 25°C to peak temperature | 6 minutes max. | 8 minutes max. |

Note(s):

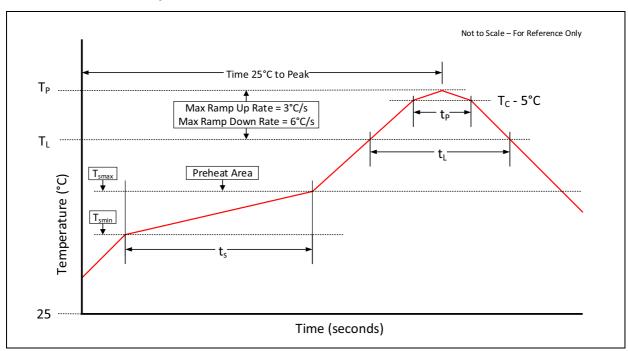
1. Tolerance for peak profile temperature (TP) is defined as a supplier minimum and a user maximum.

Page 76

Document Feedback [v2-00] 2021-Nov-23



Figure 100: **Solder Reflow Profile Graph**



Storage Information

Moisture Sensitivity

Optical characteristics of the device can be adversely affected during the soldering process by the release and vaporization of moisture that has been previously absorbed into the package. To ensure the package contains the smallest amount of absorbed moisture possible, each device is baked prior to being dry packed for shipping. Devices are dry packed in a sealed aluminized envelope called a moisture-barrier bag with silica gel to protect them from ambient moisture during shipping, handling, and storage before use.

Shelf Life

The calculated shelf life of the device in an unopened moisture barrier bag is 12 months from the date code on the bag when stored under the following conditions:

• Shelf Life: 12 months

• Ambient Temperature: <40°C

• Relative Humidity: <90%

Rebaking of the devices will be required if the devices exceed the 12 month shelf life or the Humidity Indicator Card shows that the devices were exposed to conditions beyond the allowable moisture region.

ams Datasheet Page 77 **Document Feedback**



Floor Life

The module has been assigned a moisture sensitivity level of MSL 3. As a result, the floor life of devices removed from the moisture barrier bag is 168 hours from the time the bag was opened, provided that the devices are stored under the following conditions:

• Floor Life: 168 hours

• Ambient Temperature: <30°C

• Relative Humidity: <60%

If the floor life or the temperature/humidity conditions have been exceeded, the devices must be rebaked prior to solder reflow or dry packing.

Rebaking Instructions

When the shelf life or floor life limits have been exceeded, rebake at 50°C for 12 hours.

Page 78

Document Feedback

[v2-00] 2021-Nov-23



Ordering & Contact Information

Figure 101: **Ordering Information**

| Ordering Code | Address | Interface | Delivery Form | Delivery Quantity |
|---------------|---------|-----------------------|---------------|-------------------|
| TSL25853P | 0x39 | 1.8V I ² C | Tape & Reel | 10000 pcs/reel |
| TSL25853PM | 0x39 | 1.8V I ² C | Tape & Reel | 1000 pcs/reel |

Buy our products or get free samples online at:

www.ams.com/Products

Technical Support is available at: www.ams.com/Technical-Support

Provide feedback about this document at:

www.ams.com/Document-Feedback

For further information and requests, e-mail us at:

ams_sales@ams.com

For sales offices, distributors and representatives, please visit: www.ams.com/Contact

Headquarters

ams AG **Tobelbader Strasse 30** 8141 Premstaetten Austria, Europe

Tel: +43 (0) 3136 500 0 Website: www.ams.com

ams Datasheet Page 79 [v2-00] 2021-Nov-23 **Document Feedback**



RoHS Compliant & ams Green Statement

RoHS: The term RoHS compliant means that ams AG products fully comply with current RoHS directives. Our semiconductor products do not contain any chemicals for all 6 substance categories plus additional 4 substance categories (per amendment EU 2015/863), including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, RoHS compliant products are suitable for use in specified lead-free processes.

ams Green (RoHS compliant and no Sb/Br/Cl): ams Green defines that in addition to RoHS compliance, our products are free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material) and do not contain Chlorine (Cl not exceed 0.1% by weight in homogeneous material).

Important Information: The information provided in this statement represents ams AG knowledge and belief as of the date that it is provided. ams AG bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. ams AG has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. ams AG and ams AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

Page 80

Document Feedback

[v2-00] 2021-Nov-23



Copyrights & Disclaimer

Copyright ams AG, Tobelbader Strasse 30, 8141 Premstaetten, Austria-Europe. Trademarks Registered. All rights reserved. The material herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner.

Devices sold by ams AG are covered by the warranty and patent indemnification provisions appearing in its General Terms of Trade. ams AG makes no warranty, express, statutory, implied, or by description regarding the information set forth herein. ams AG reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with ams AG for current information. This product is intended for use in commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or life-sustaining equipment are specifically not recommended without additional processing by ams AG for each application. This product is provided by ams AG "AS IS" and any express or implied warranties, including, but not limited to the implied warranties of merchantability and fitness for a particular purpose are disclaimed.

ams AG shall not be liable to recipient or any third party for any damages, including but not limited to personal injury, property damage, loss of profits, loss of use, interruption of business or indirect, special, incidental or consequential damages, of any kind, in connection with or arising out of the furnishing, performance or use of the technical data herein. No obligation or liability to recipient or any third party shall arise or flow out of ams AG rendering of technical or other services.

ams Datasheet Page 81
[v2-00] 2021-Nov-23 Document Feedback



Document Status

| Document Status | Product Status | Definition |
|--------------------------|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Preview | Pre-Development | Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice |
| Preliminary Datasheet | Pre-Production | Information in this datasheet is based on products in the design, validation or qualification phase of development. The performance and parameters shown in this document are preliminary without any warranty and are subject to change without notice |
| Datasheet | Production | Information in this datasheet is based on products in ramp-up to full production or full production which conform to specifications in accordance with the terms of ams AG standard warranty as given in the General Terms of Trade |
| Datasheet (discontinued) | Discontinued | Information in this datasheet is based on products which conform to specifications in accordance with the terms of ams AG standard warranty as given in the General Terms of Trade, but these products have been superseded and should not be used for new designs |

Page 82ams DatasheetDocument Feedback[v2-00] 2021-Nov-23



Revision Information

| Changes from 1-00 (2021-May-24) to current revision 2-00 (2021-Nov-23) | Page |
|------------------------------------------------------------------------|------|
| Removed "Confidential" from footer | all |
| Updated Absolute Maximum Ratings | 5 |
| Updated CONTROL Register | 44 |
| Updated MEAS_SEQR_RESIDUAL_1_AND_WAIT Register | 49 |
| Updated note under PCB Pad Layout | 74 |
| Updated Ordering Information | 79 |

Note(s):

- 1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
- 2. Correction of typographical errors is not explicitly mentioned.

ams Datasheet Page 83 Document Feedback



Content Guide

- 1 General Description
- 2 Key Benefits & Features
- 2 Applications
- 3 Block Diagram
- 4 Pin Assignments
- 5 Absolute Maximum Ratings
- **6** Optical Characteristics
- 8 Electrical Characteristics
- 10 Timing Characteristics
- 12 Typical Operating Characteristics

14 Detailed Description

- 15 State Machine Diagrams
- 17 I²C Protocol

18 Register Overview

- 18 Register Map
- 22 Register Descriptions
- 22 UV_CALIB Register
- 23 MOD_CHANNEL_CTRL Register
- 23 ENABLE Register
- 24 MEAS_MODE0 Register
- 25 MEAS_MODE1 Register
- 25 SAMPLE_TIME0 Register
- 26 ALS_NR_SAMPLES0 Register
- 27 FD_NR_SAMPLES0 Register
- 27 FD_NR_SAMPLES1 Register
- 28 WTIME Register
- 28 ALS Interrupt Low Threshold Registers
- 29 ALS Interrupt High Threshold Registers
- 30 Device Identification Registers
- 30 STATUS Register
- 31 ALS_STATUS Register
- 32 ALS Data Registers
- 32 ALS_STATUS2 Register
- 33 ALS_STATUS3 Register
- 33 STATUS2 Register
- 34 STATUS3 Register
- 35 STATUS4 Register
- 36 CFG0 Register
- 37 CFG1 Register
- 37 CFG2 Register
- 38 CFG3 Register
- 39 CFG4 Register
- 40 CFG5 Register
- 41 CFG6 Register
- 42 CFG7 Register
- 42 CFG8 Register
- 42 CFG9 Register
- 43 AGC Number of Samples Registers
- 43 TRIGGER_MODE Register
- 44 CONTROL Register
- 45 INTENAB Register

Page 84

Document Feedback

[v2-00] 2021-Nov-23



- 46 SIEN Register
- 46 MOD_COMP_CFG1 Register
- 47 MEAS_SEQR_FD_0 Register
- 47 MEAS_SEQR_ALS_FD_1 Register
- 48 MEAS_SEQR_APERS_AND_VSYNC_WAIT Register
- 48 MEAS_SEQR_RESIDUAL_0 Register
- 49 MEAS_SEQR_RESIDUAL_1_AND_WAIT Register
- 50 MEAS_SEQR_STEP0_MOD_GAINX_L Register
- 50 MEAS_SEQR_STEP0_MOD_GAINX_H Register
- 51 MEAS SEQR STEP1 MOD GAINX L Register
- 51 MEAS SEQR STEP1 MOD GAINX H Register
- 51 MEAS_SEQN_STELL_MOD_GAINY_ITREGISTEL
- 52 MEAS_SEQR_STEP2_MOD_GAINX_L Register
- 52 MEAS_SEQR_STEP2_MOD_GAINX_H Register
- 53 MEAS_SEQR_STEP3_MOD_GAINX_L Register
- 53 MEAS_SEQR_STEP3_MOD_GAINX_H Register
- 54 MEAS_SEQR_STEP0_MOD_PHDX_SMUX_L Register
- 55 MEAS_SEQR_STEP0_MOD_PHDX_SMUX_H Register
- 56 MEAS_SEQR_STEP1_MOD_PHDX_SMUX_L Register
- 57 MEAS_SEQR_STEP1_MOD_PHDX_SMUX_H Register
- 58 MEAS_SEQR_STEP2_MOD_PHDX_SMUX_L Register
- 59 MEAS_SEQR_STEP2_MOD_PHDX_SMUX_H Register
- 60 MEAS_SEQR_STEP3_MOD_PHDX_SMUX_L Register
- 61 MEAS_SEQR_STEP3_MOD_PHDX_SMUX_H Register
- 61 MOD_CALIB_CFG0 Register
- 62 MOD_CALIB_CFG2 Register
- 63 VSYNC Period Registers
- 63 VSYNC Period Target Registers
- 63 VSYNC_PERIOD_TARGET Register
- 64 VSYNC_CONTROL Register
- 65 VSYNC_CFG Register
- 66 VSYNC GPIO INT Register
- 67 MOD_FIFO_DATA_CFG0 Register
- 68 MOD_FIFO_DATA_CFG1 Register
- 69 MOD FIFO DATA CFG2 Register
- 69 FIFO_THR Register
- 70 FIFO Level Registers
- 70 FIFO STATUSO Registers
- 71 FIFO_DATA Registers
- 72 Application Information
- 73 Package Drawings & Markings
- 74 PCB Pad Layout
- 75 Tape & Reel Information
- 76 Soldering & Storage Information
- 76 Soldering Information
- 77 Storage Information
- 77 Moisture Sensitivity
- 77 Shelf Life
- 78 Floor Life
- 78 Rebaking Instructions
- 79 Ordering & Contact Information
- 80 RoHS Compliant & ams Green Statement



- 81 Copyrights & Disclaimer
- **82 Document Status**
- 83 Revision Information

Page 86ams DatasheetDocument Feedback[v2-00] 2021-Nov-23